

Detectors R&D and Applications at CIAE

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China Institute of Atomic Energy
DRD1 Meeting, CERN Dec. 12, 2024



Outline

- R&D of GEM at CIAE
- R&D of MicroMegs at CIAE
- R&D of RPC at CIAE
- R&D of Other Detectors and Electronics at CIAE
- Summary and Perspective



Developments of Advanced Gas Detectors

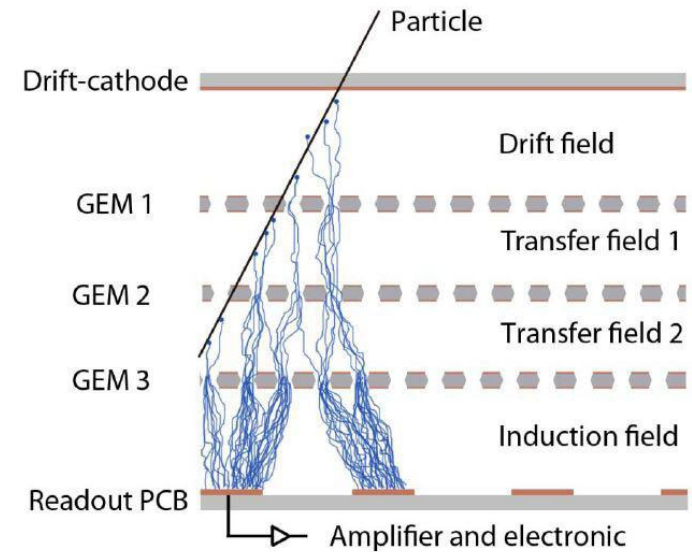
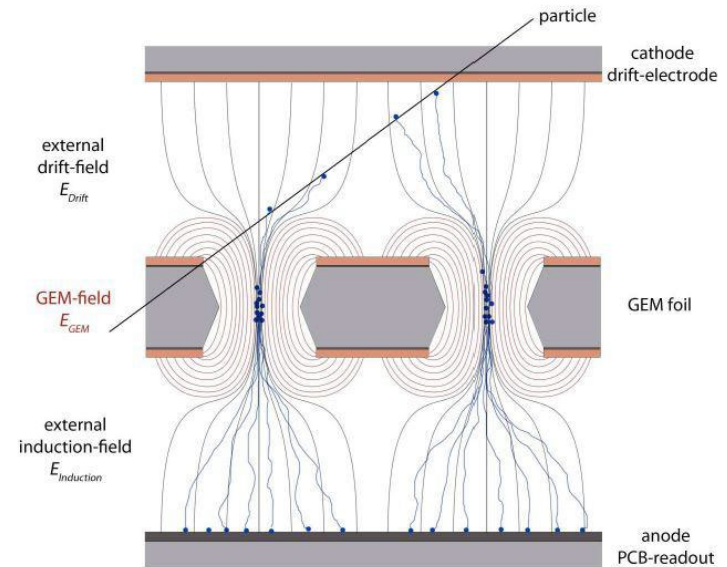


R&D of GEM at CIAE



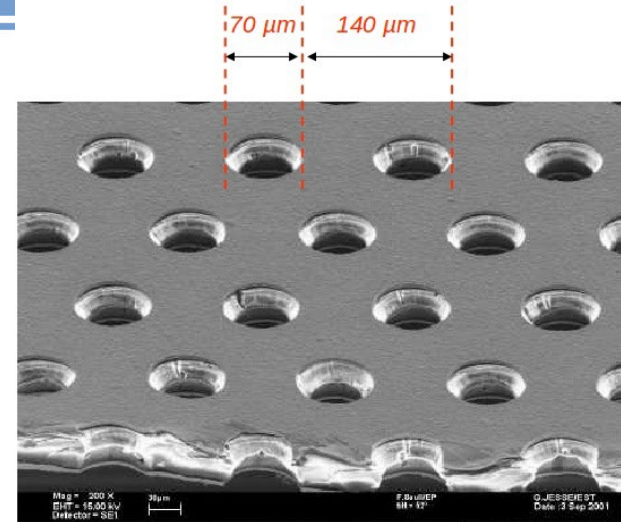
Structure of GEM

- **GEM detector:**
 - Cathode, Drift field, GEM foil, Induction field and Readout board.
 - **GEM foil: the most important part of GEM detector . Normally 3 GEM foils in one GEM detector.**

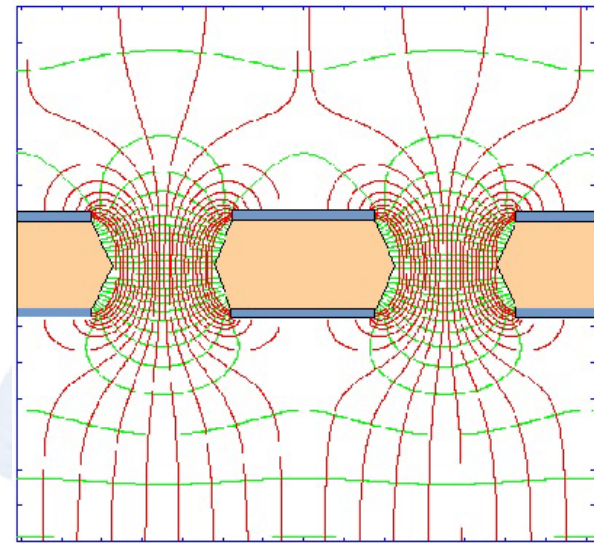


GEM Foil

1. Typical GEM Foil has 3 layers, two $5\mu\text{m}$ thick copper foils and one $50\mu\text{m}$ thick kapton foil in the middle.
2. Diameter of the hole is $70\mu\text{m}$, and the distance between them is $140\mu\text{m}$.
3. Apply electric voltages on the two copper layers.
4. Electric Field is very strong in the hole area, and weak outside the hole area.



GEM Foil

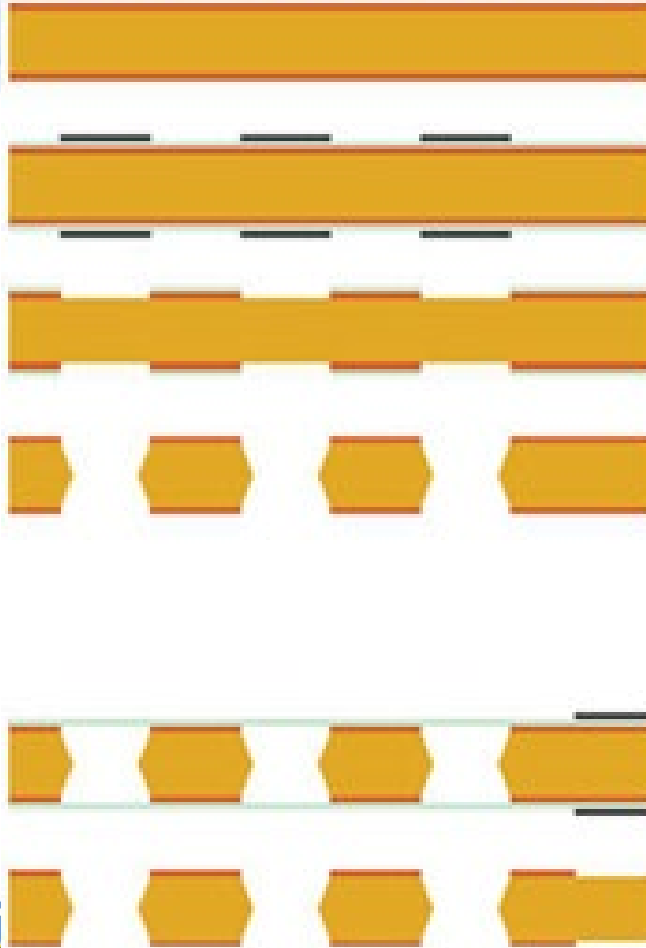


GEM Field



The Procedure of GEM Foil

Double mask photolithography



50 μm kapton foil 5 μm
copper clad on both sides

Photoresist coating,
masking, exposure

Photoresist development,
copper etching

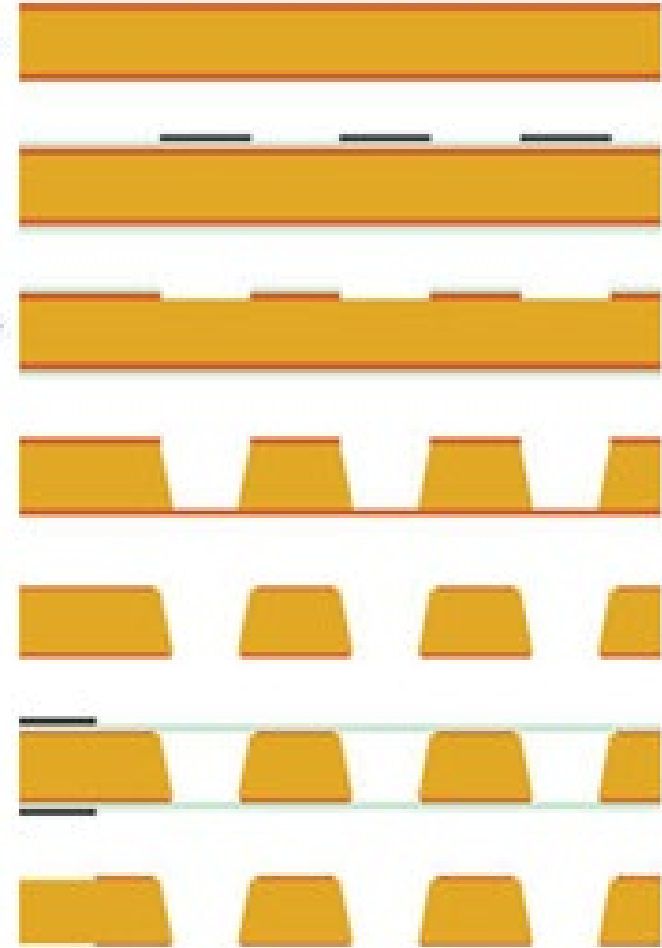
Kapton etching

Metal etching

Second masking,
exposure

Development, etching,
final cleaning

Single mask photolithography



GEM License and Training

CIAE is the first chinese institution which signed officially the LICENSE AGREEMENT FOR MANUFACTURING AND COMMERCIALISATION OF GEM FOILS AND GEM-BASED PRODUCTS with CERN.

I took a training for GEM foil at CERN.



北京市275信箱

Photolithography Room Construction At CIAE



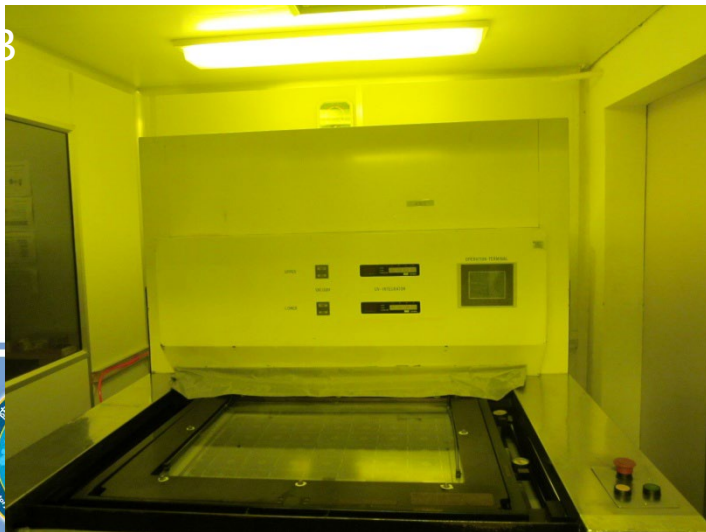
The Equipments for Lamination and Exposure of Dry Film Photoresist



Lamination and exposure of dry film photoresist are the most important and difficult steps for GEM foil production.

We have established a yellow light zone, Hot Roll Lamination (HRL) machine and Exposure system.

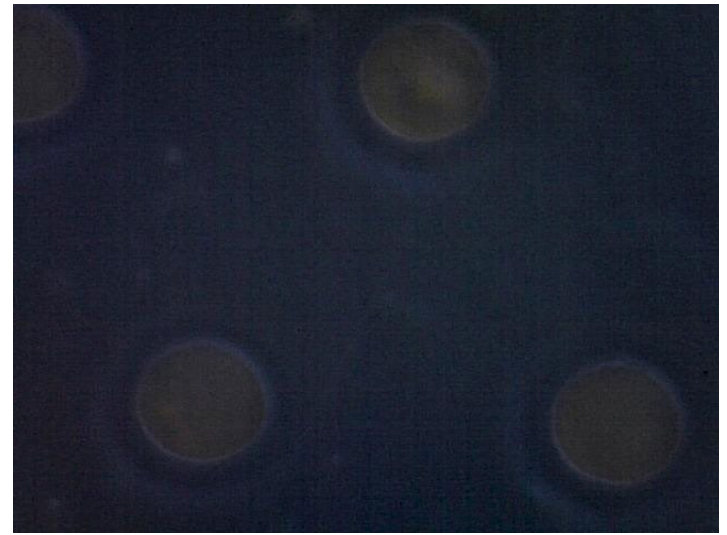
We invited a senior engineer from a famous electronic factory to CIAE and taught the PCB technology.



Exposure of Dry Film Photoresist

We use negative photoresist for GEM image transfer, unexposed areas are relatively unchanged and easily washed out during the development.

To obtain an identical copy of the photo-mask to the photoresist, vertical sidewalls in the resist are important.

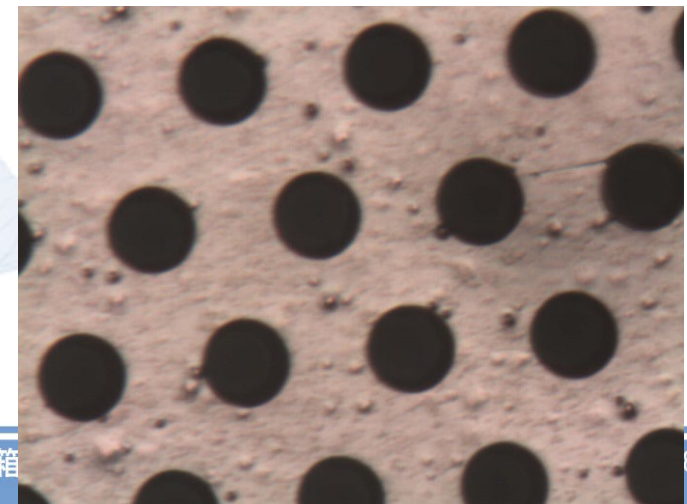
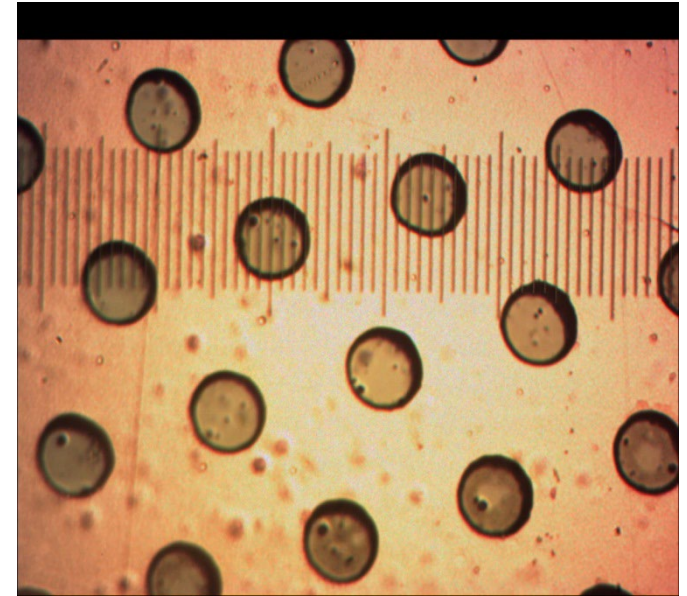


We can observe the image transfer with good accuracy.



Copper Etching and Kapton Etching

- The size of the hole is 70um as expected

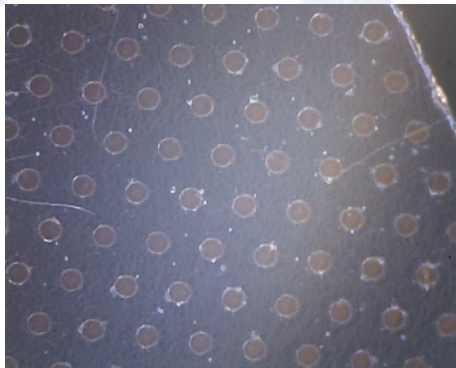


Etching Room Construction



Comparison of Foils Made in Different Conditions

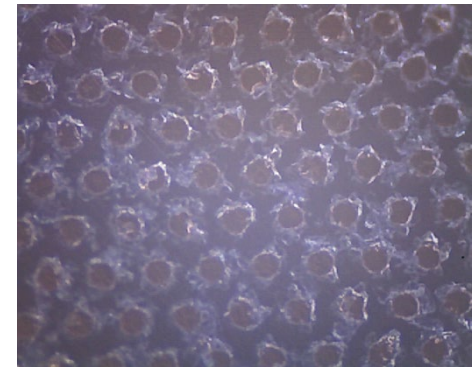
Insufficient development



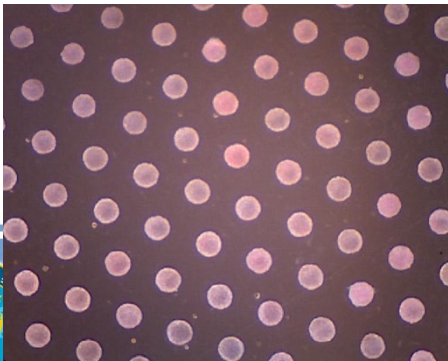
Good development



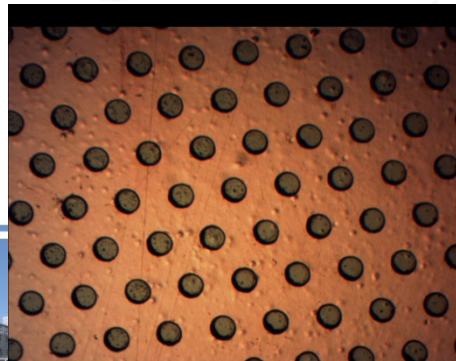
Excessive development



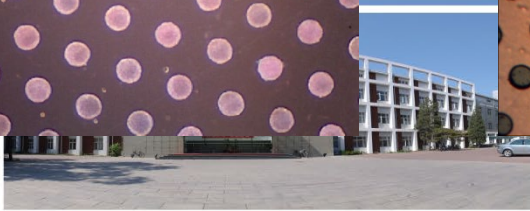
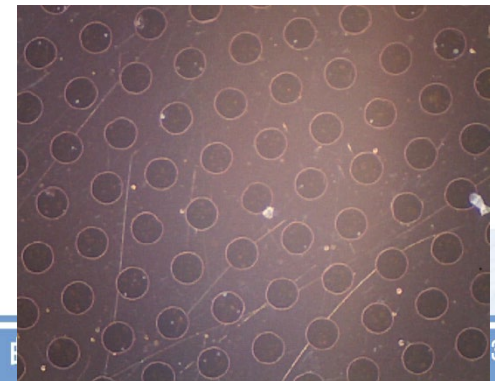
Insufficient copper etching



Good copper etching

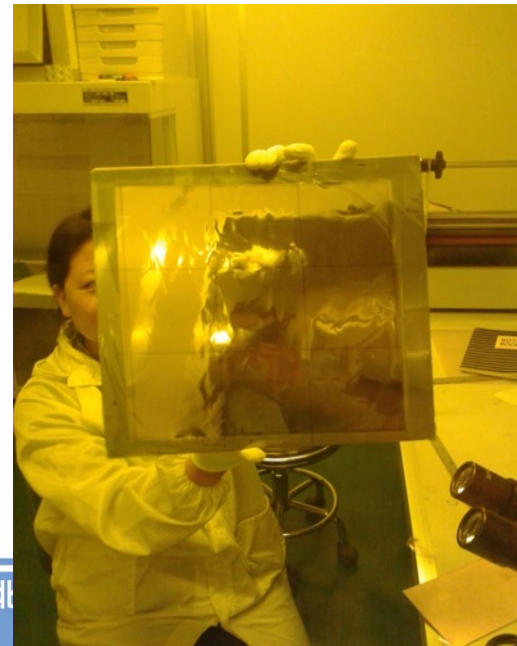


Excessive copper etching

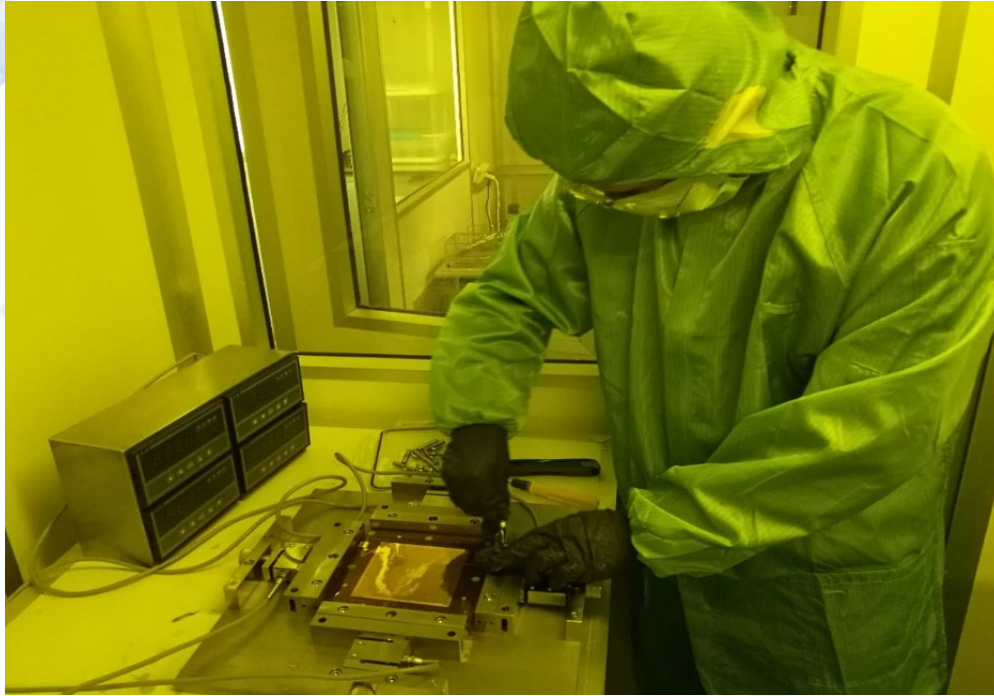


50cm*50cm GEM Foil

- The 50cm*50cm GEM foils were made successfully.
- single-mask method was used.
- We did more than 200 samples before reaching this result.



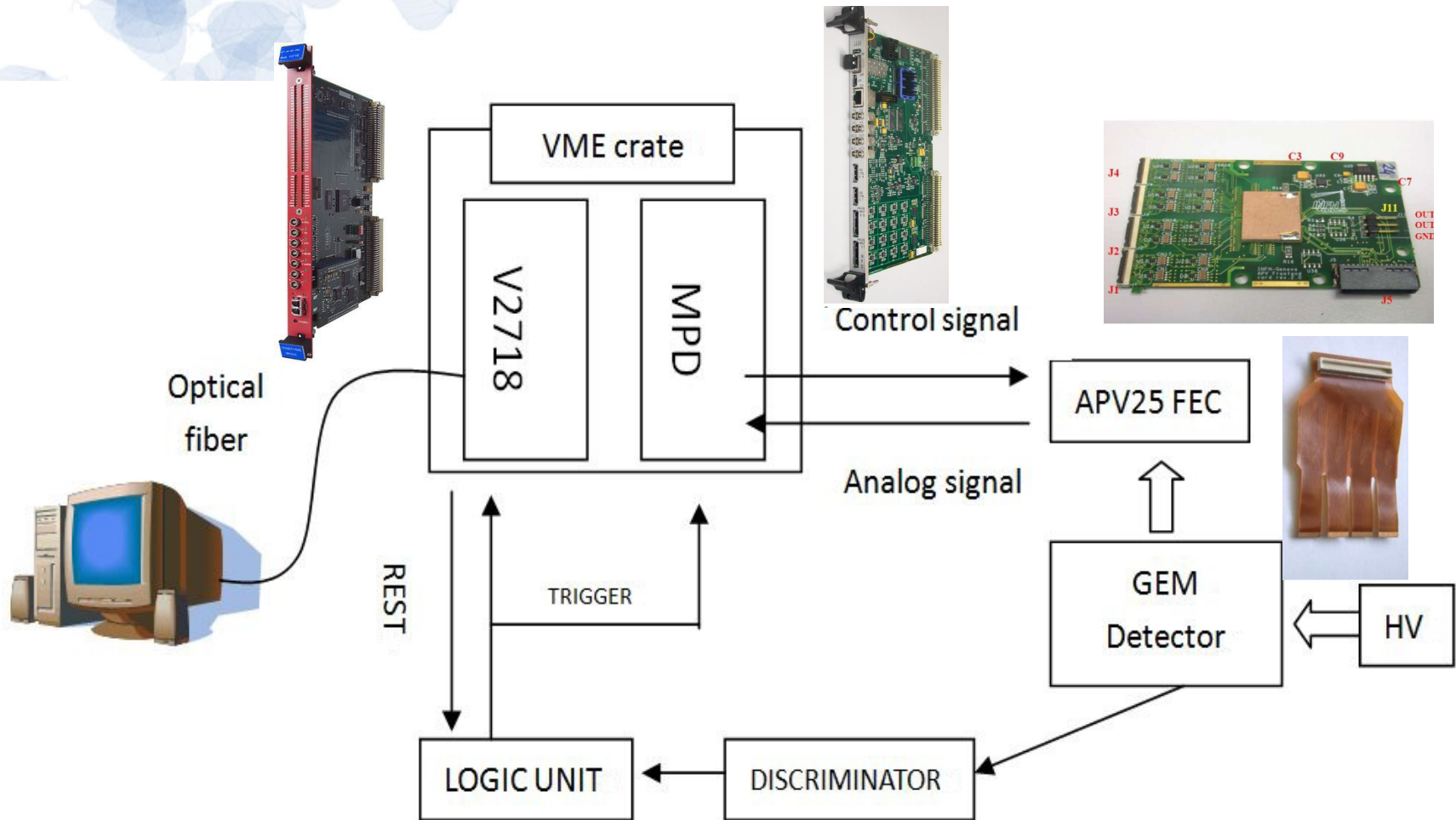
GEM Detector Assembly at CIAE



active area 10*10cm



GEM Test system



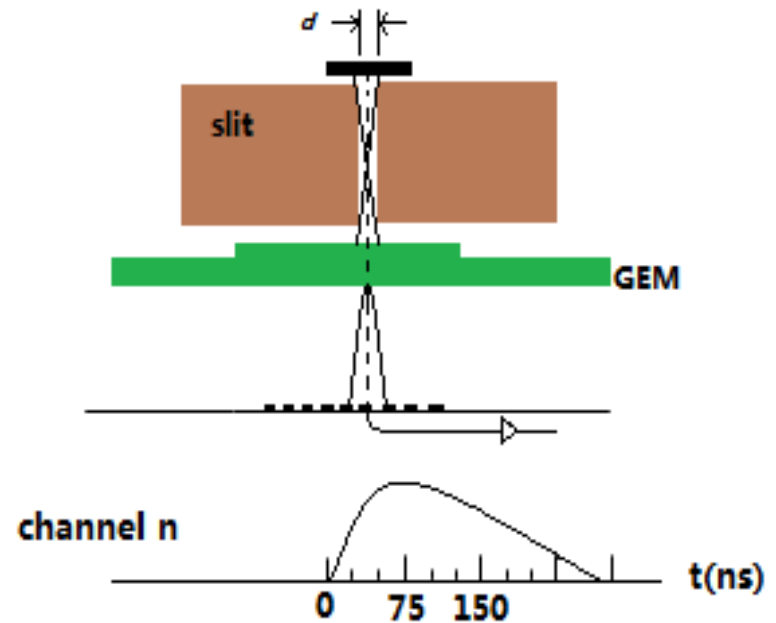
Spatial resolution

$$\sigma_{\text{tot}}^2 = \sigma_{\text{GEM}}^2 + c_1 \sigma_{\text{geometry}}^2$$

When: $\sigma_{\text{geometry}} \ll \sigma_{\text{GEM}}$

$$\sigma_{\text{tot}}^2 \cong \sigma_{\text{GEM}}^2$$

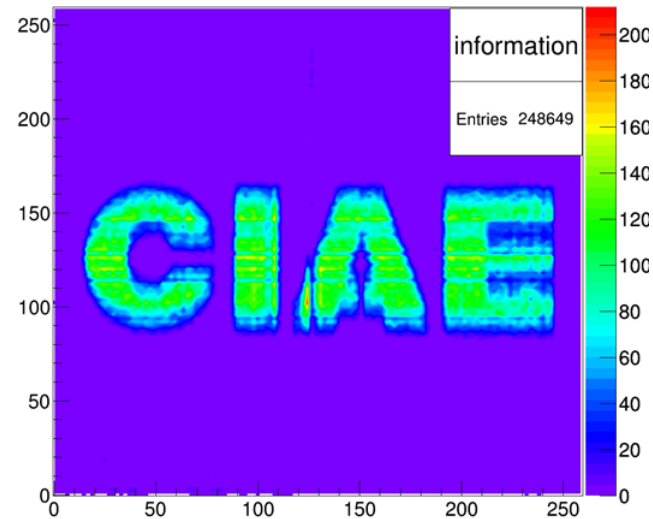
- **Slit(um): 20;**
- **Ar: CO₂=70% : 30%;**
- **HV: 3600V;**
- **The distance between strips: 400um.**



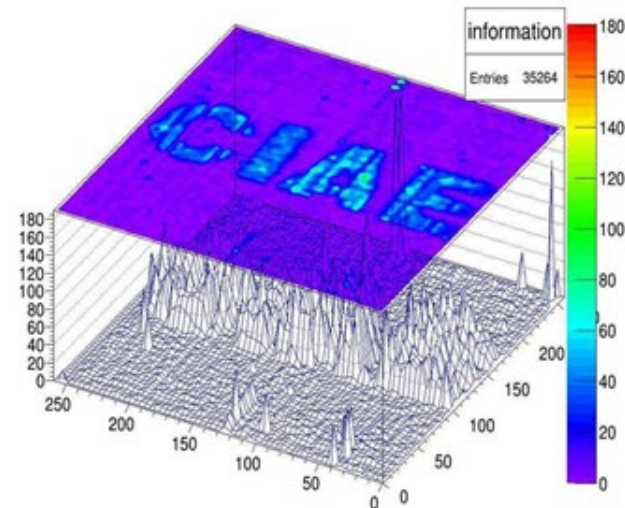
Spatial resolution $\approx 76\mu\text{m}$



X-ray imaging @ CIAE

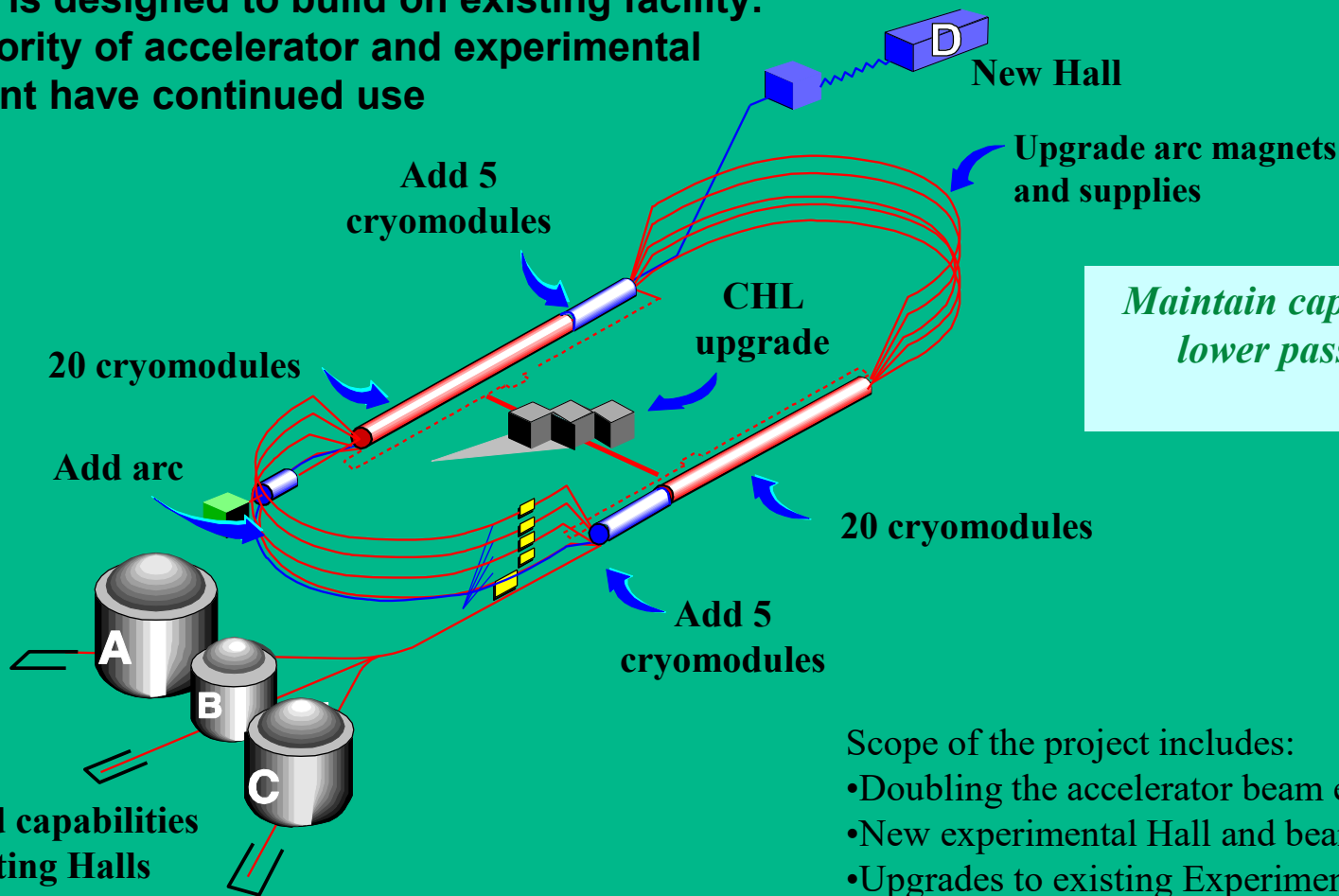


- X ray Energy: 8.9keV;
- 256 channels for each dimension(512 channel in total);
- 4 APV FECs were used (2 for each dimension)



JLab 12 GeV Upgrade

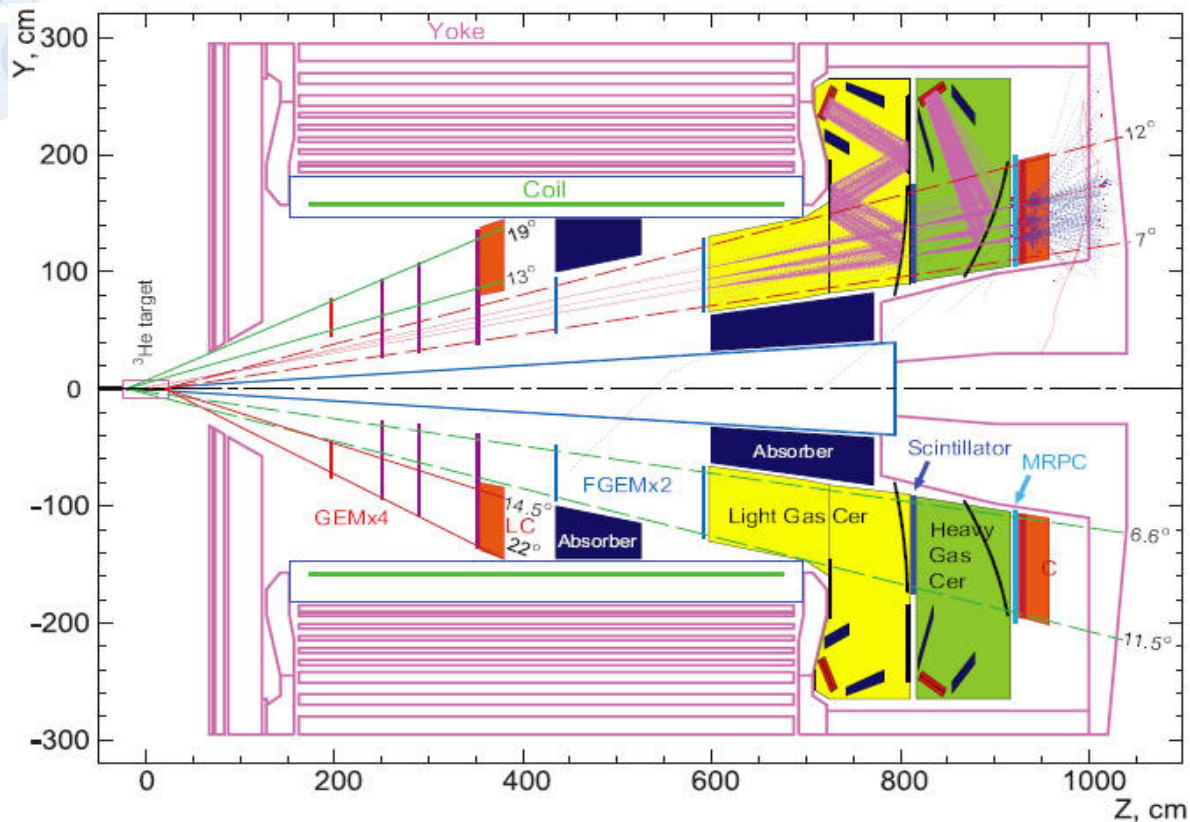
Upgrade is designed to build on existing facility:
vast majority of accelerator and experimental
equipment have continued use



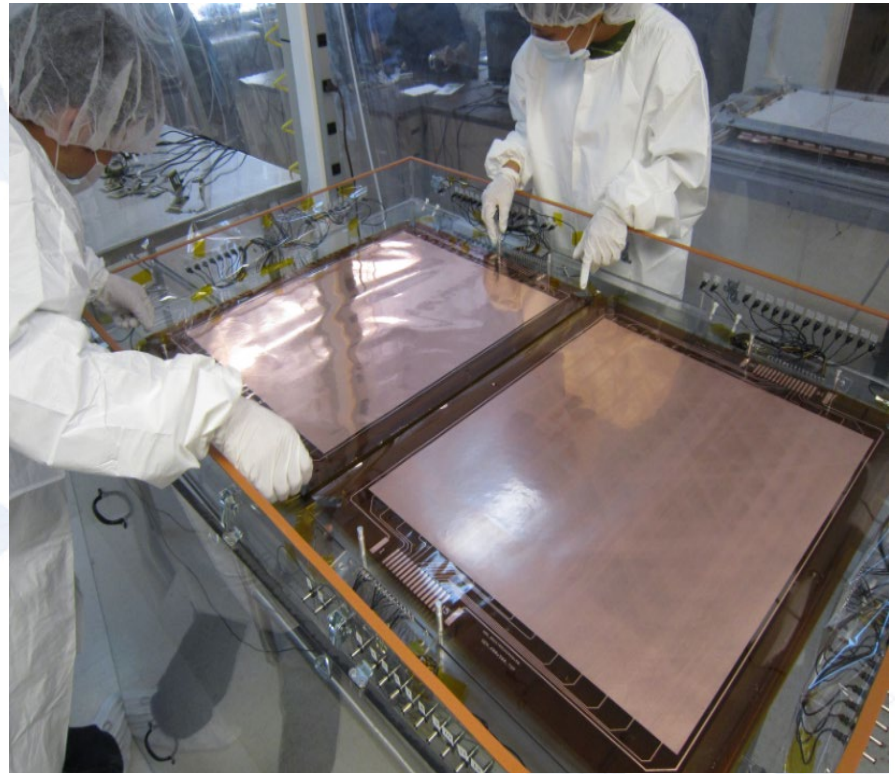
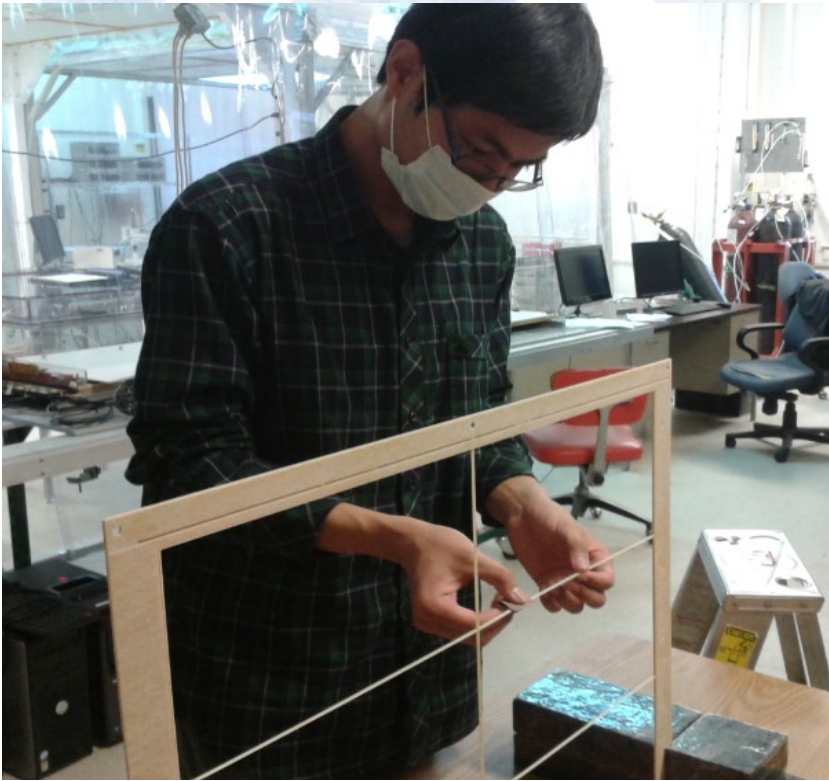
Scope of the project includes:

- Doubling the accelerator beam energy
- New experimental Hall and beamline
- Upgrades to existing Experimental Halls

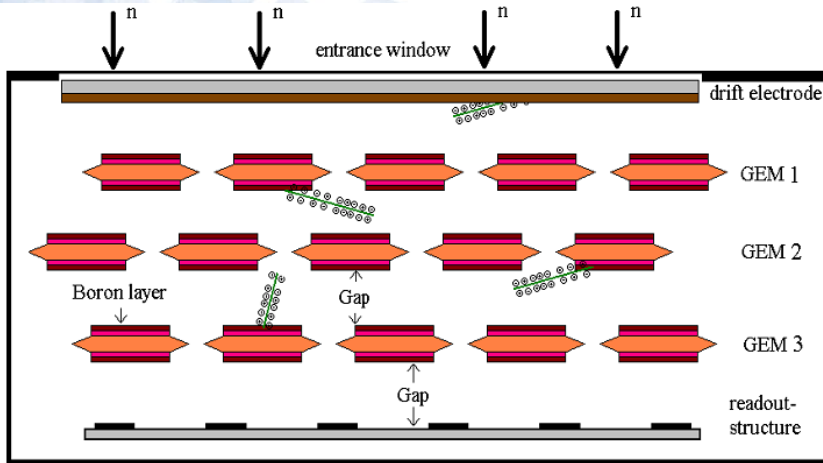
GEM: SoLID Spectrometer at JLab



Students working at JLAB and UVA

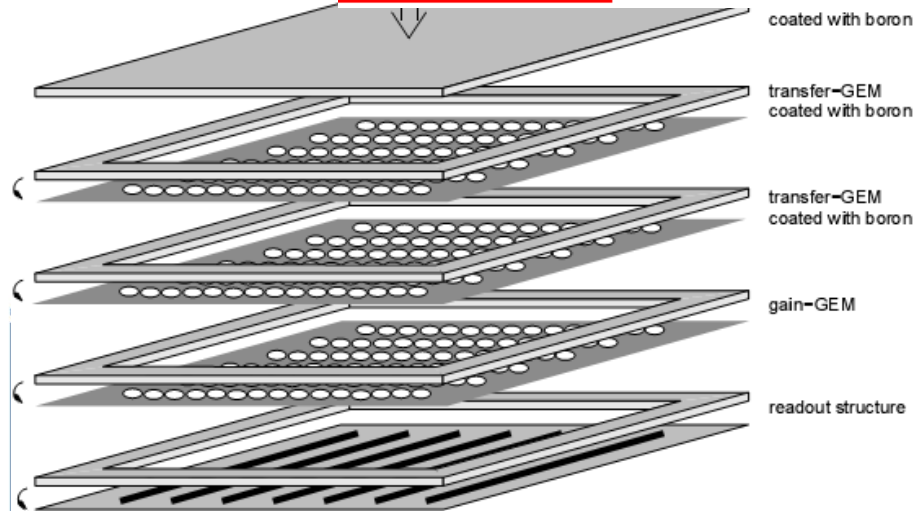
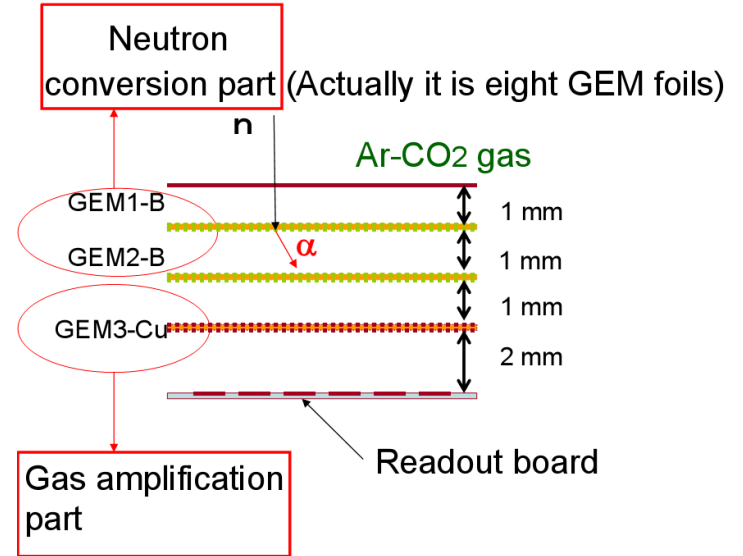


GEM: Neutron Detection



— Kapton — Copper — Boron — ionization track

KEK



R&D of MicroMegs at CIAE



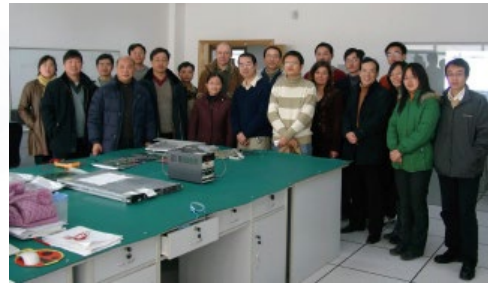
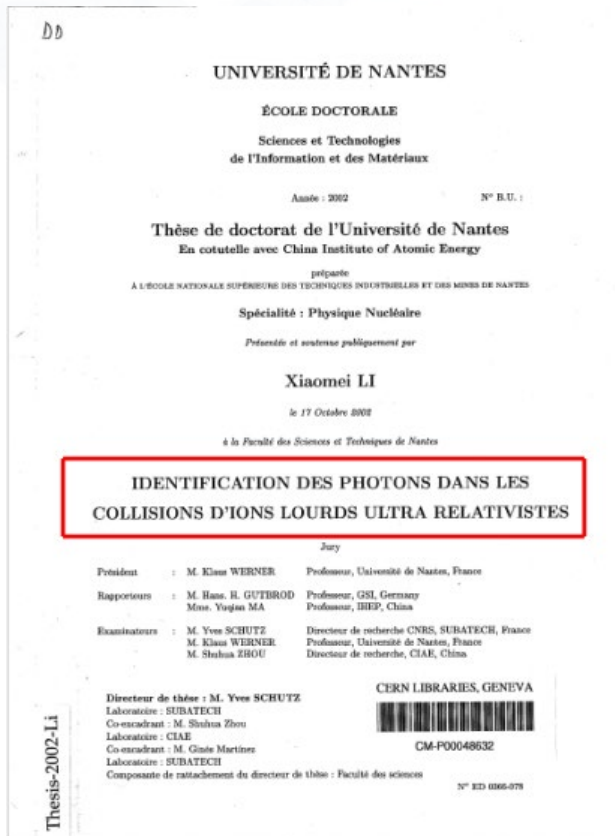
Micromegas Classifications

- **Classic Micromegas**
 - Mesh on a frame
- **Bulk Micromegas**
 - photolithography process is used to attach the mesh on the PCB.
- **Microbulk Micromegas**
 - Mesh and PCB made on a unique kapton foil, the mesh layer is thinner.



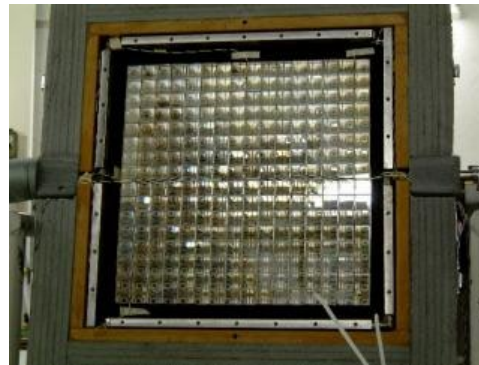
13/12/2024

The France-China Collaboration: first joint-PhD

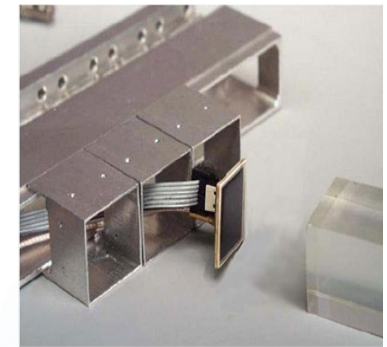


Xiaomei LI
(CIAE Beijing)

Cotutorship PhD Subatech-CIAE
1999-2002
Supervisor: Yves Schutz

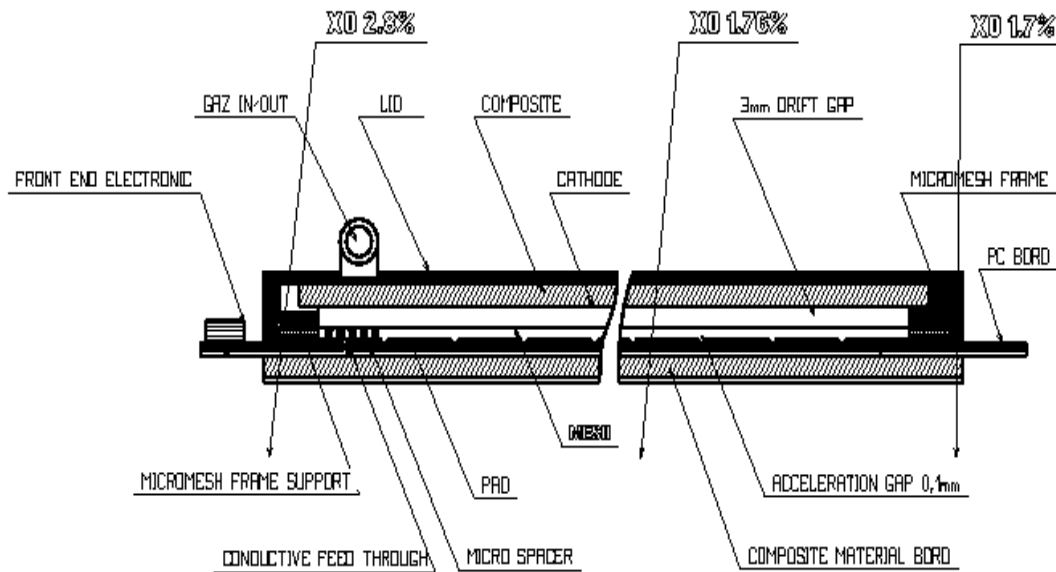


PHOS prototype with PbWO_4 crystals



MICROME GAS detector

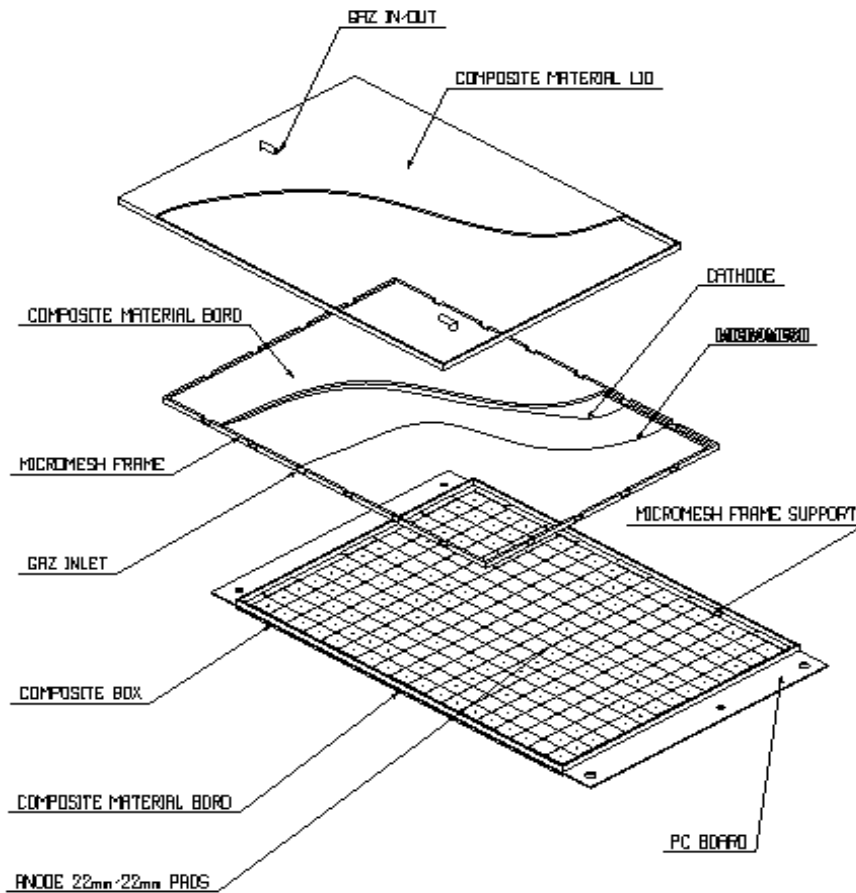
- active area $415 \times 375 \text{mm}^2$
- 3mm drift gap
- $100 \mu\text{m}$ amplification gap
- a high electric field in the amplification region (50kV/cm)
- a low electric field in the drift region (2kV/cm)



Ph.D in SUBATECH,
France



MICROME GAS detector



- The anode is made of a 1.0mm thick electronic board(GI180) on one side with $2.2*2.2 \text{ cm}^2$ copper pad on other side with signal collecting strip
- The micromesh is made of pure Nickel
- The cathode consists of $9 \mu\text{m}$ layer of copper, glued on a 3mm thick plate made of composite material

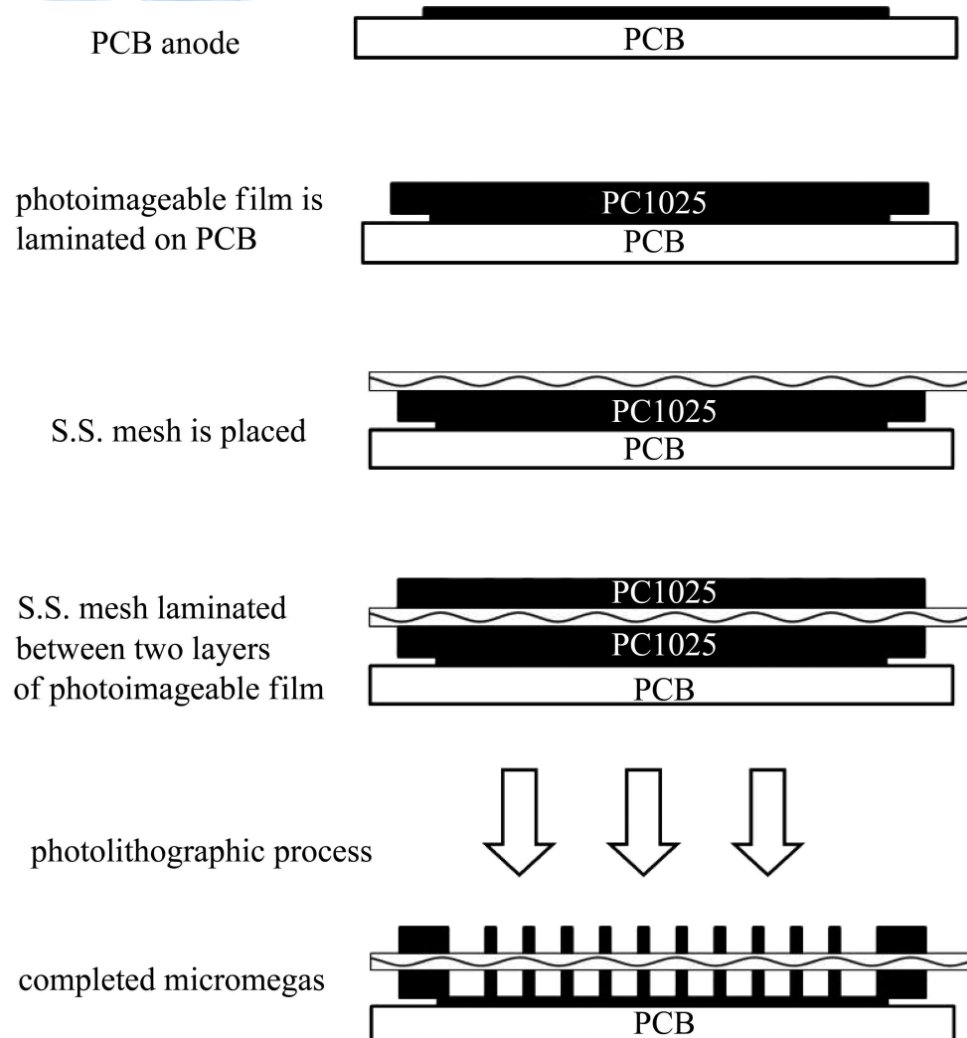


Two different designs to keep micro-spacers

1. The amplification gap is defined by cylindrical micro-spacers of $200\ \mu\text{m}$ high and $250\ \mu\text{m}$ in diameter, glued on to the anode-pads with a pitch of 2 mm in both directions.
2. The micro-spacers are replaced by an insulating grid sandwiched between the micro-mesh and the anode plane



Structure of Bulk MicroMegas

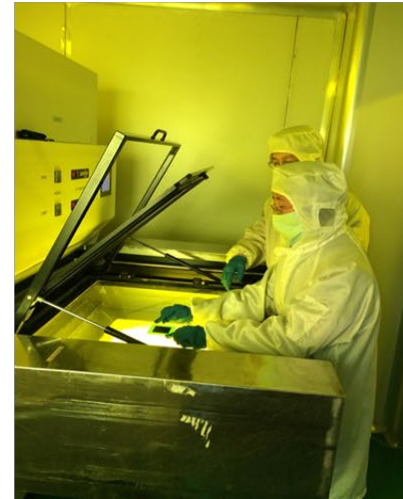


Reference: Study of bulk micromegas detector
Chinese Physics C Vol. 34, No. 10, Oct., 2010

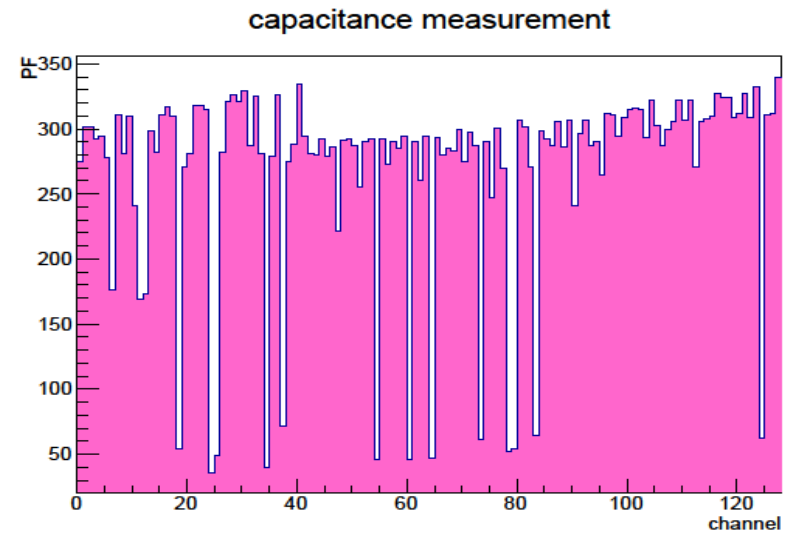


Manufacture of MicroMegas at CIAE

- Completed R&D and mass production of bulk MicroMegas.
- Developed new photoetching MicroMegas.

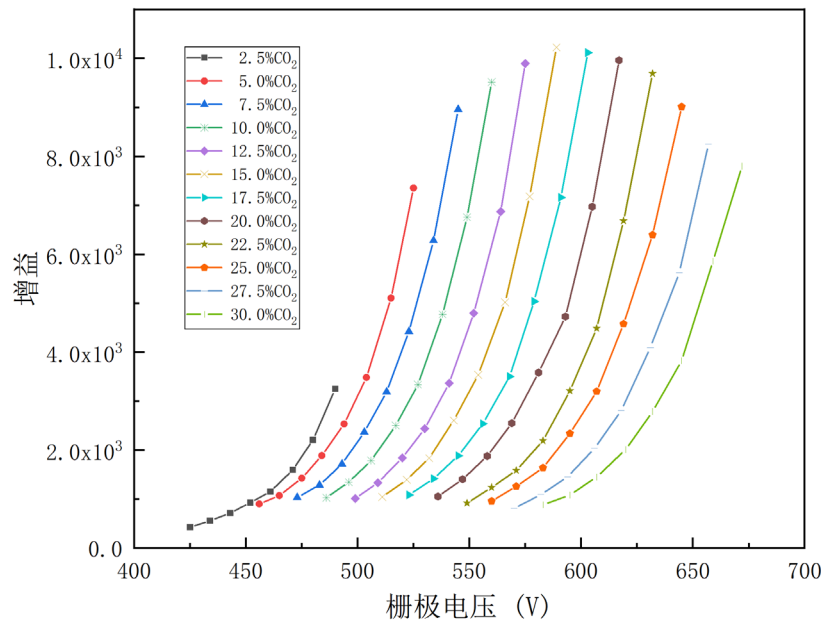


Capacitance and Resistance Automatic Testing System Invented by CIAE



Performance of Micromegas

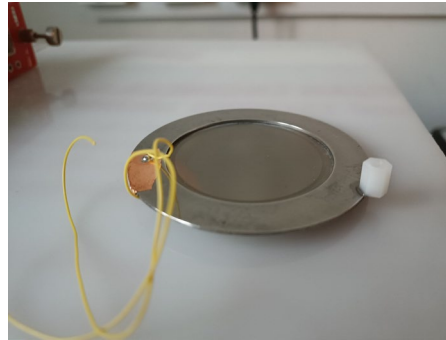
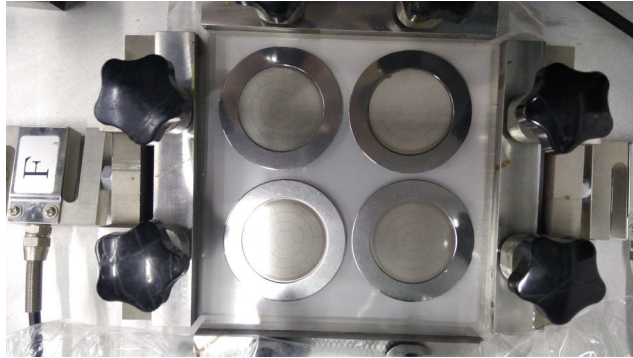
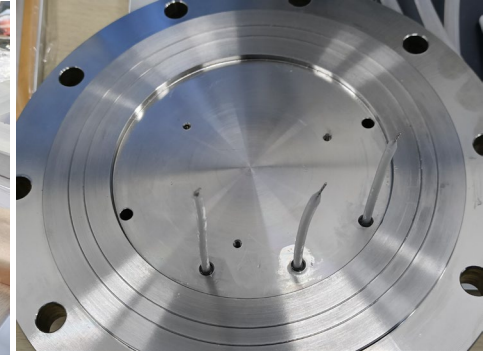
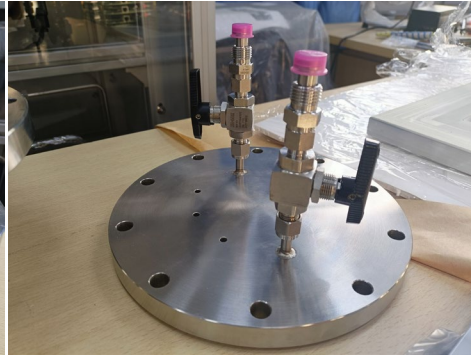
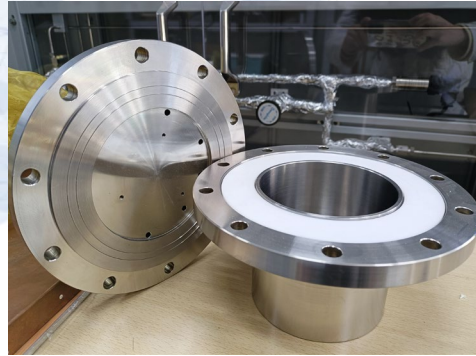
The gain of the detector varies with the grid voltage under different ratios of Ar and CO₂ working gases



The Micromegas developed independently by our team achieves the best energy resolution of 17.5% in Ar and iC₄H₁₀ gases.



Development of Sealed Chamber MM



Crystal Glue 水晶滴胶

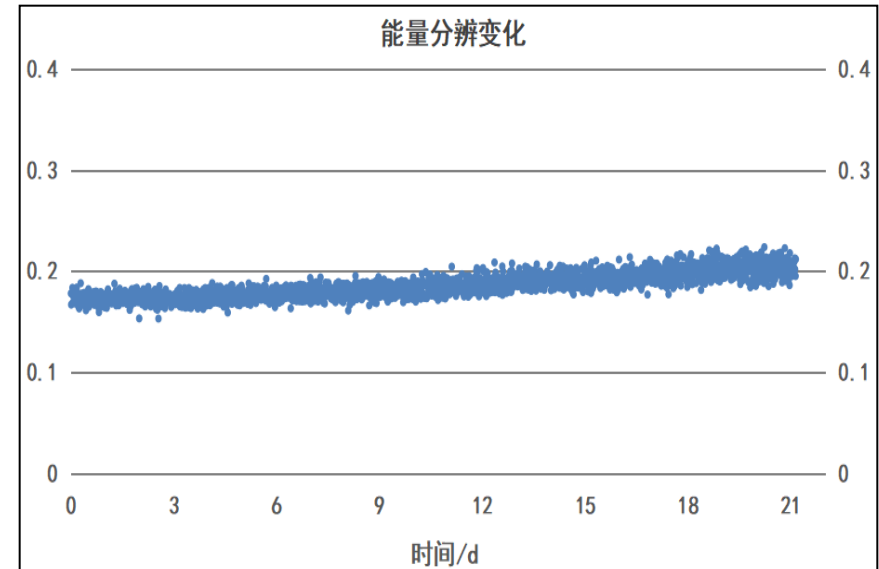
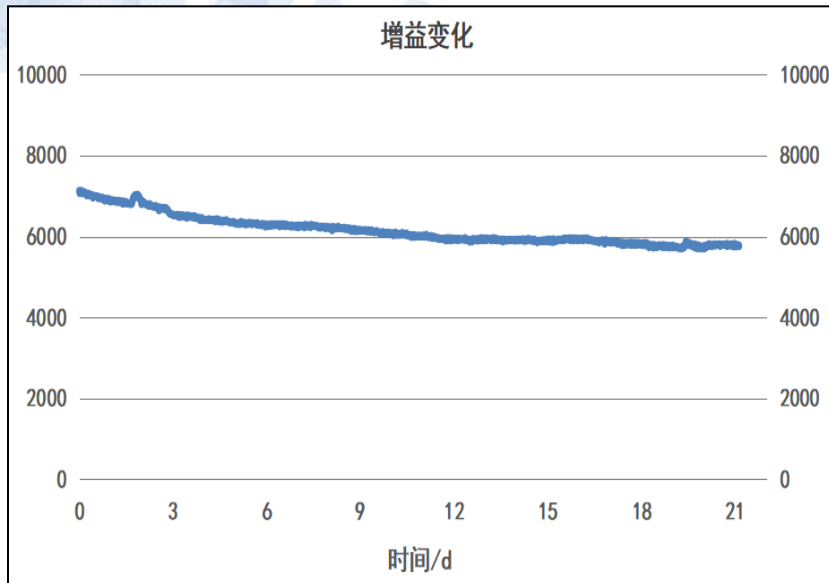
- 超透明
- 固化快
- 自然消泡

室温25°C 1厘米厚度
约15小时左右固化
适合2厘米厚度以下的产品
至室温高可值厚度越薄
完全固化后硬度85D左右
AB重量比例3:1
电子秤配比
AB量杯配比25:10



Development of Sealed Chamber MM

$V_{\text{Mesh}}: 510\text{V}$ $V_{\text{Drift}} 900\text{V}$

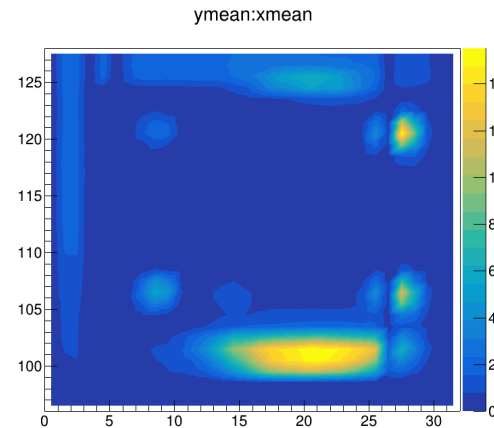
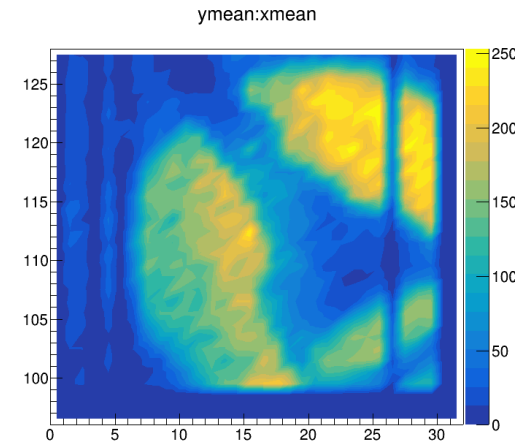


The energy resolution of the sealed micro-pattern gas detector has consistently remained at an excellent level after 21 days of continuous measurement.

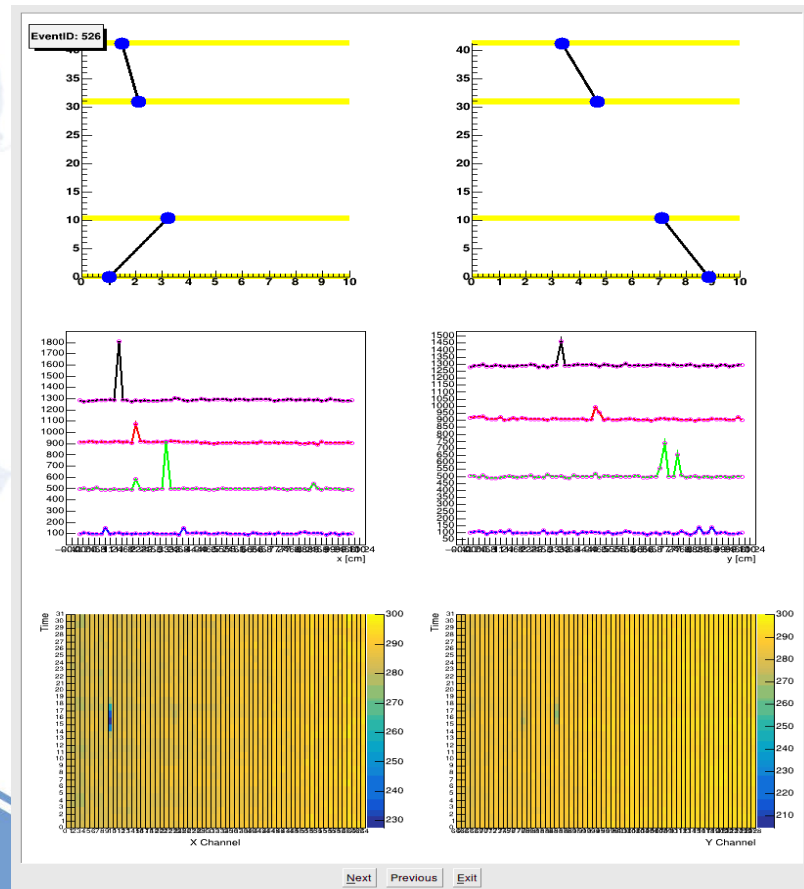


Micromegas X-Ray Imaging

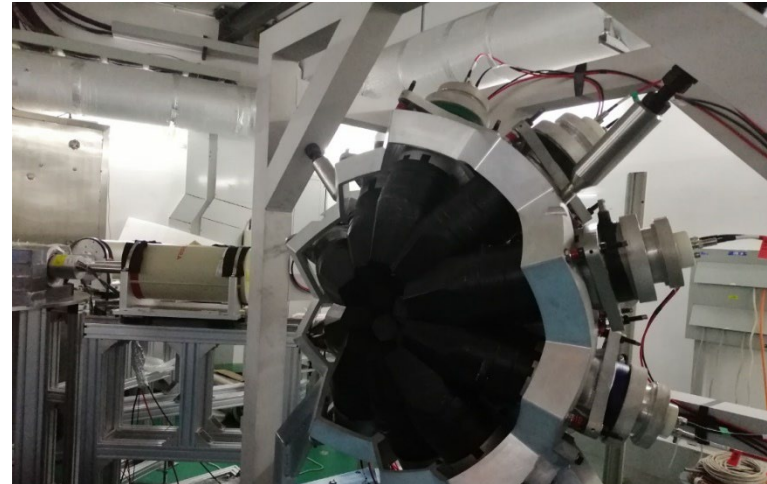
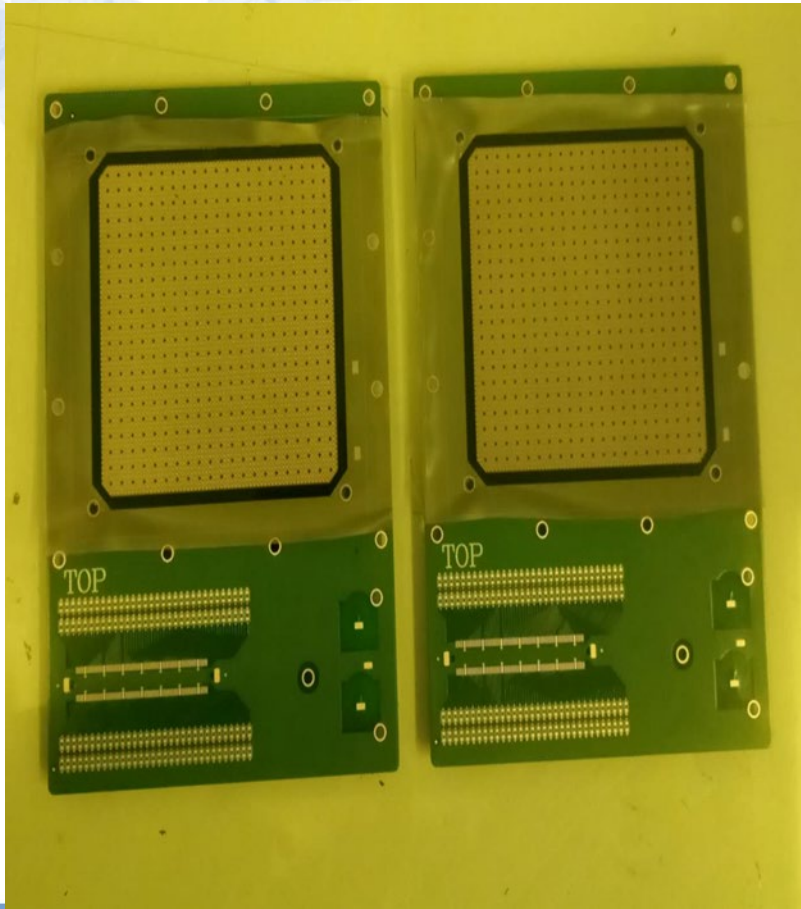
- Argon + 30%CO₂
- Mesh: -550V(max -620V)
- Drift: -2500V
- 50kV X-Ray tube



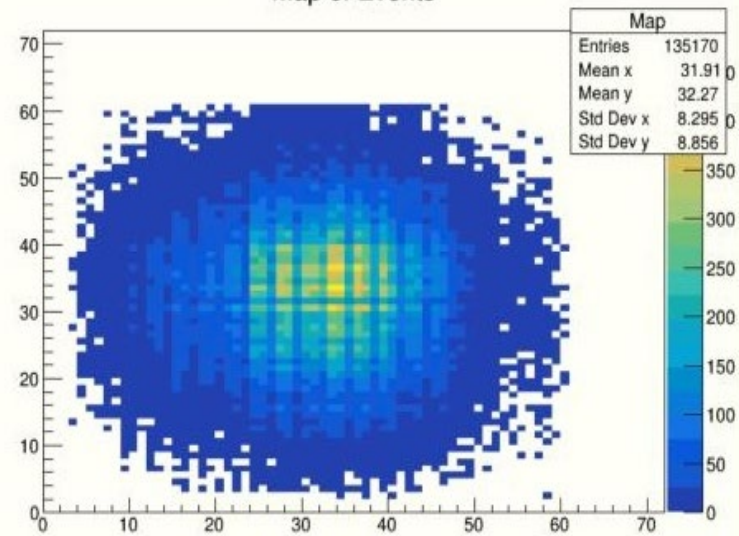
MicroMegas: Radiation Detection



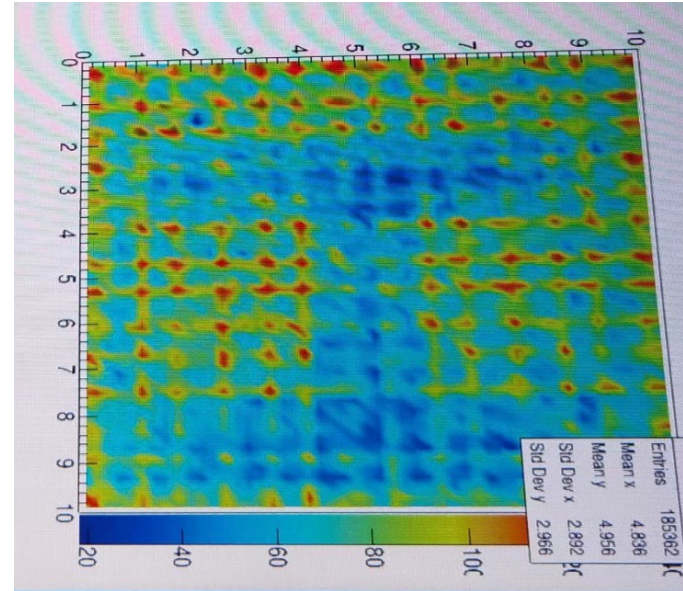
Neutron imaging at China Spallation Neutron Source



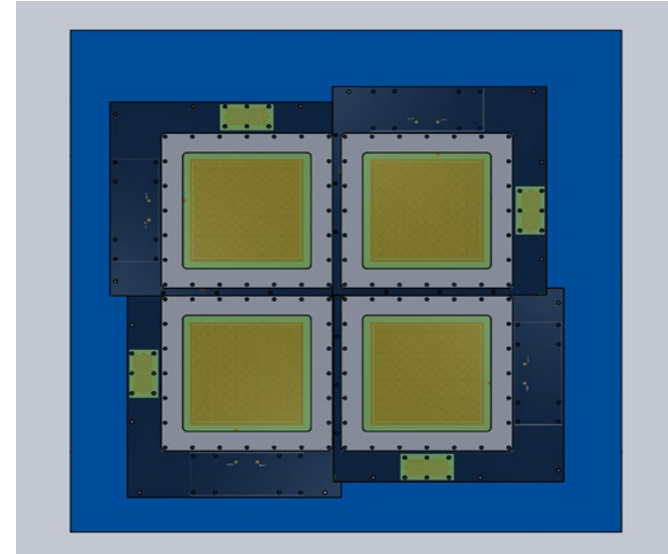
Map of Events



Neutron Imaging at CIAE



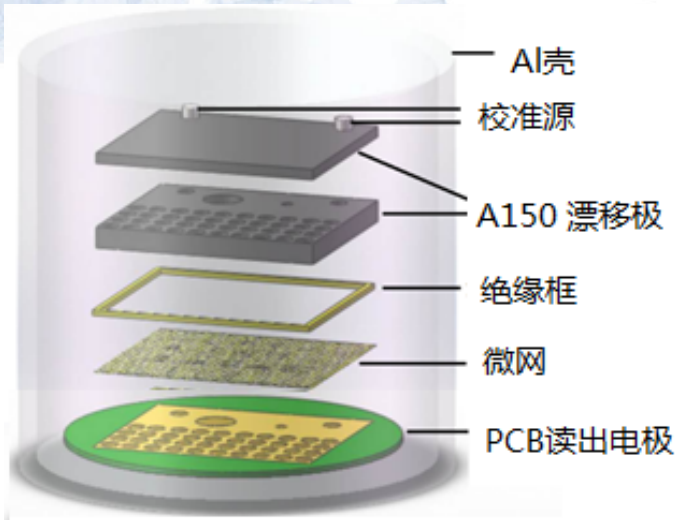
Neutron Imaging at CIAE 100MeV Cyclotron



Using 70-100MeV to measure the cyclotron neutron beam at 28 points online. It is the cyclotron neutron beam spot monitored online for the first time



MicroMegas: TEPC at CIAE



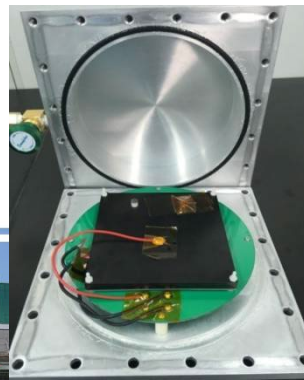
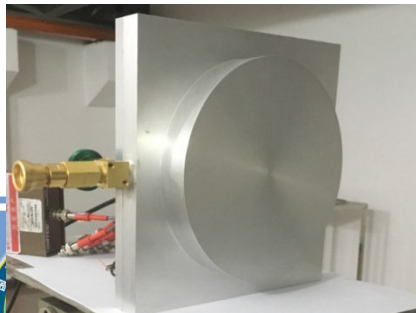
**TEPC is widely used in
microdosimetry.**

**Compare with MWPC:
Easy Assembly,
More Sensitive**

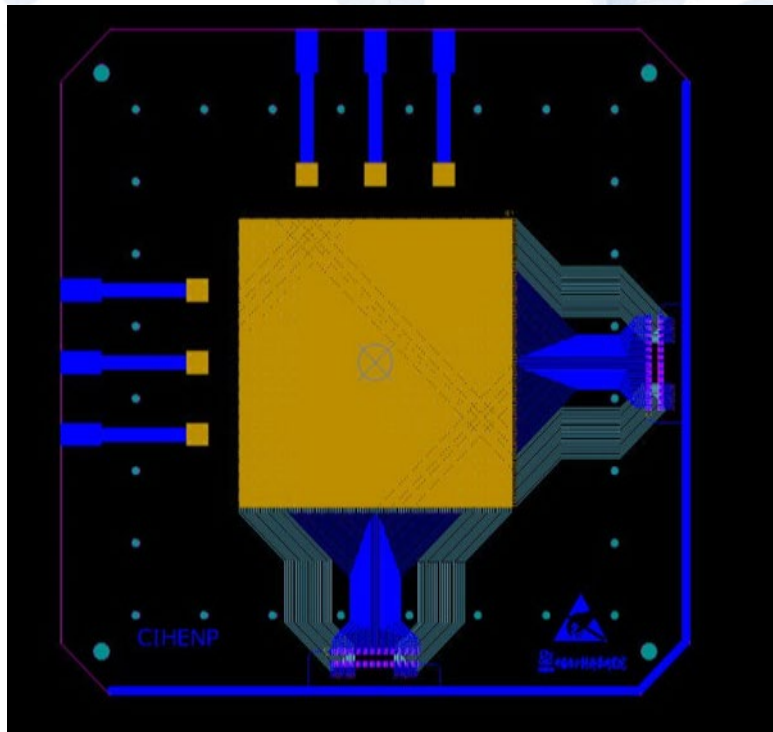
**Compare with GEM:
More stable**

Tissue Equivalent

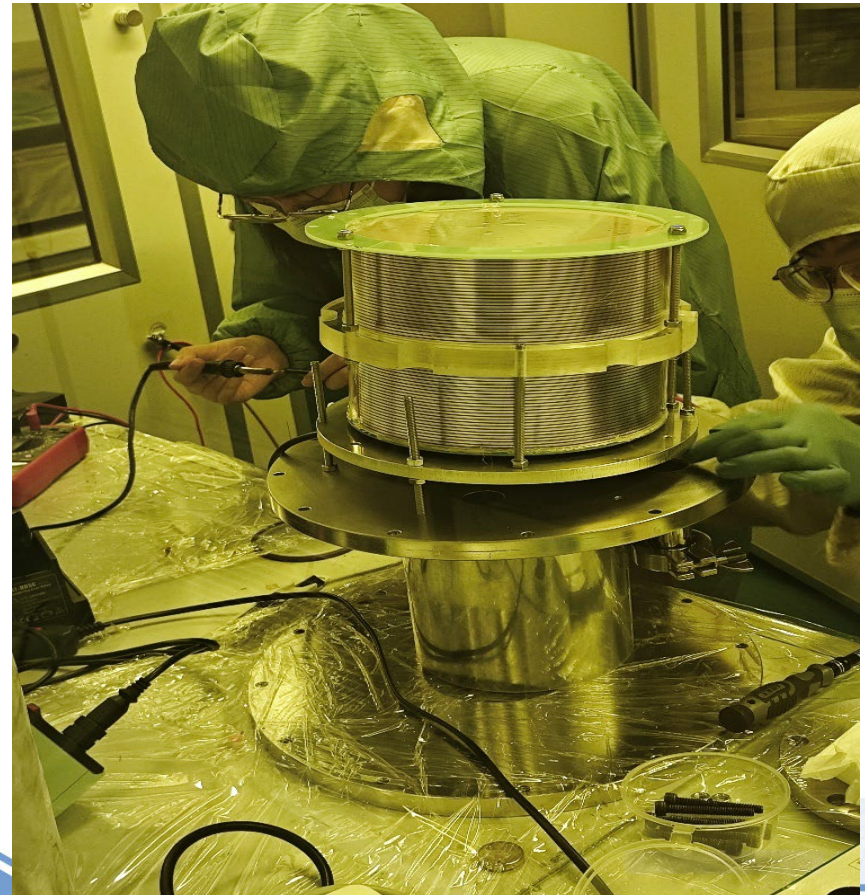
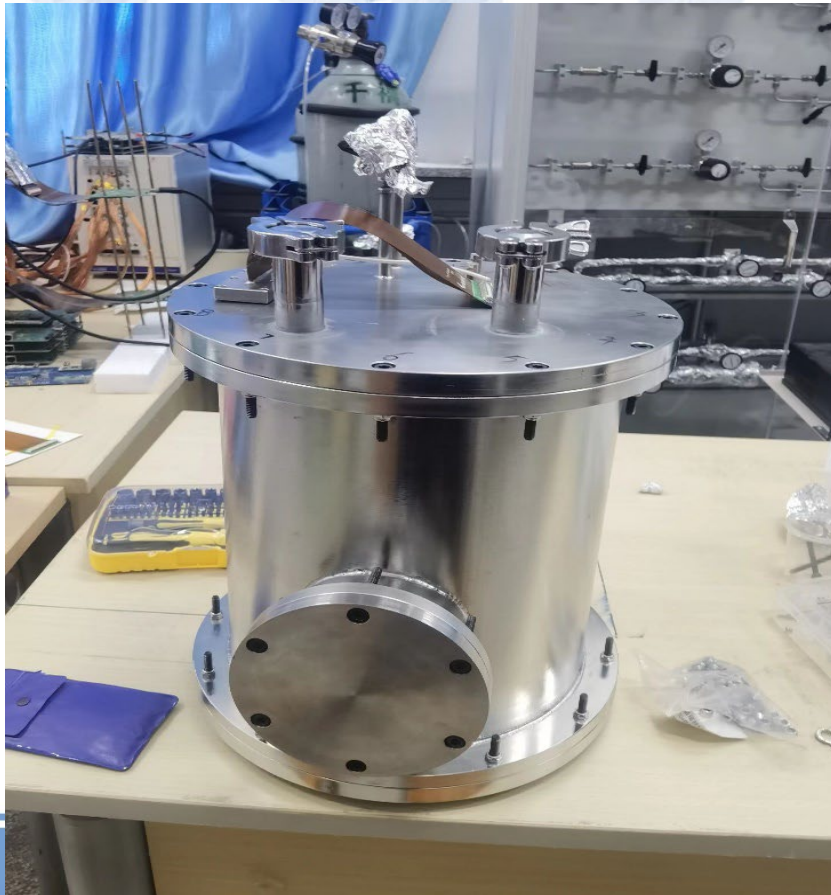
Proportional Counter



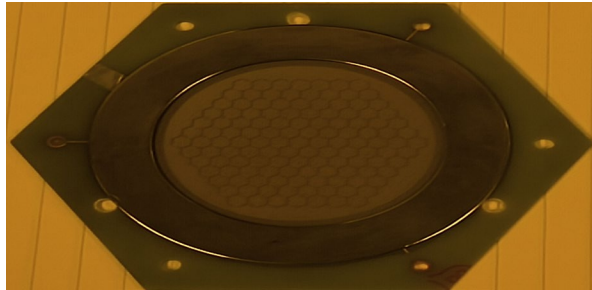
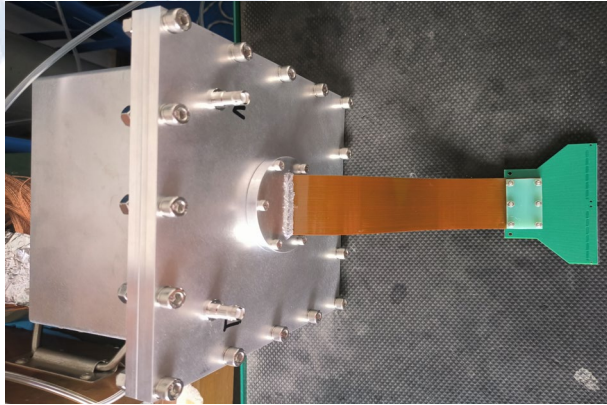
MicroMegas for the R&D of CEPC TPC



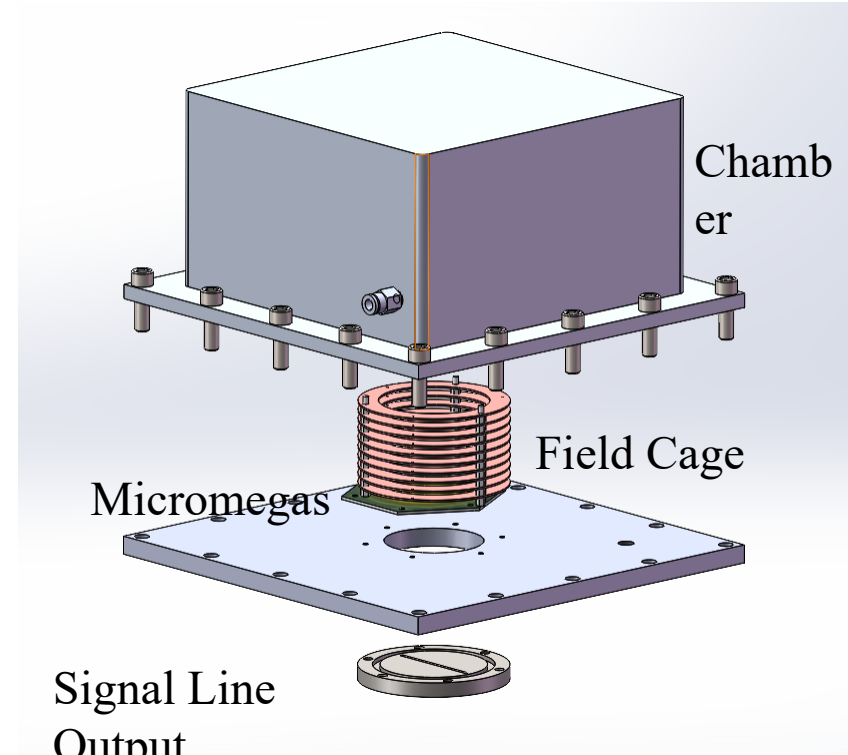
MicroMegas for R&D of Multifunction TPC



TPC Based On Micromegas



Micromegas

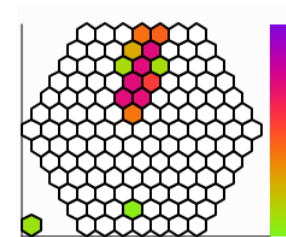
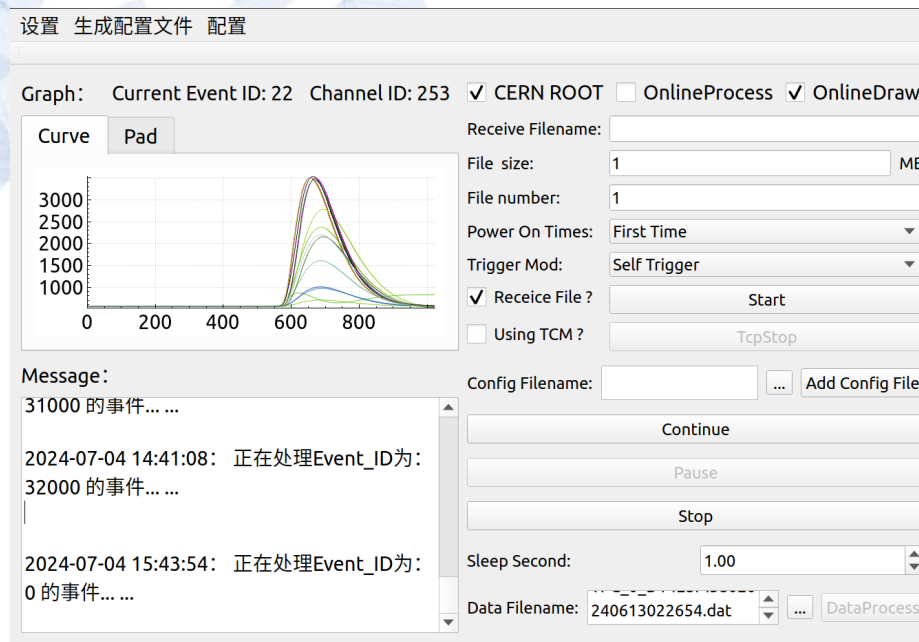
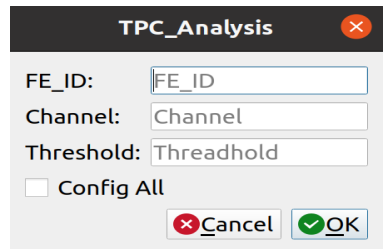
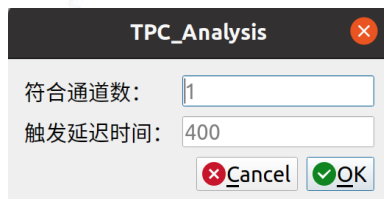


Schematic Diagram of TPC Structure



Data Acquisition Software

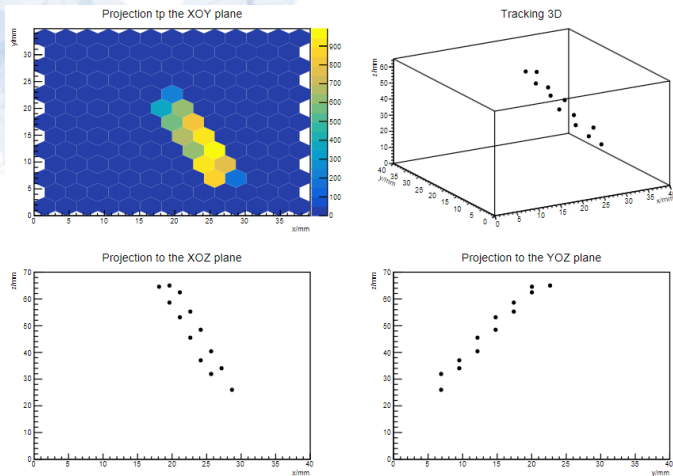
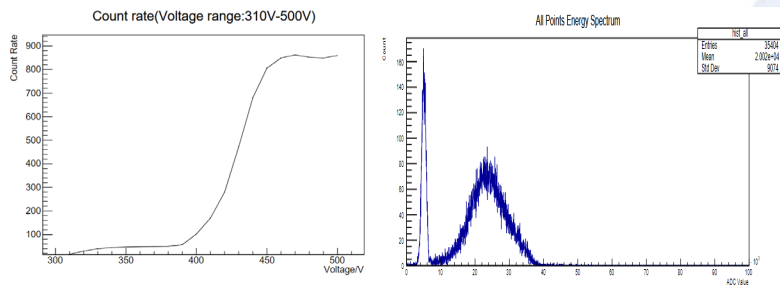
Developed supporting data acquisition software for the time projection chamber based on Qt Creator and ROOT



Real-time
Display of
Trajectory
2D
Projection

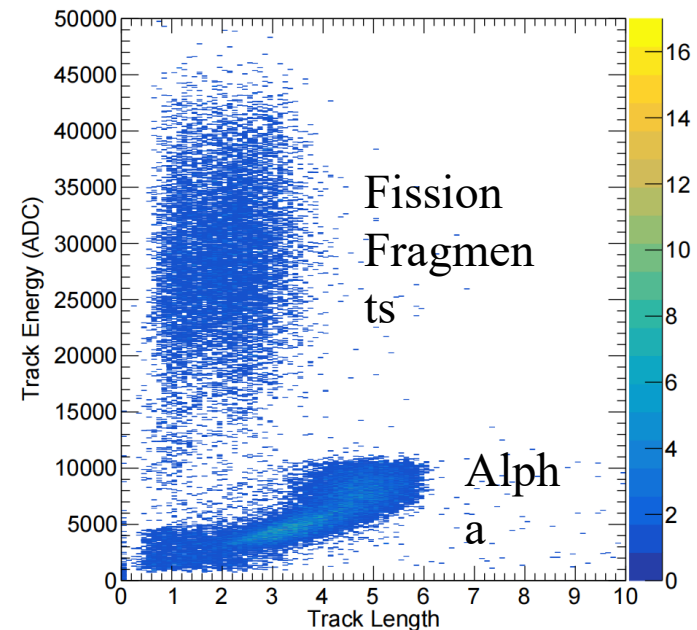
Partial
Configuration
Page



Experiment of Cf^{252}  Cf^{252} Emission Particle Trajectory Diagram

Counting Rate Curve and Energy Spectrum

We detected the Cf^{252} emission particle trajectories using the self-developed time projection chamber.



2D Statistical Diagram of Energy and Trajectory Length



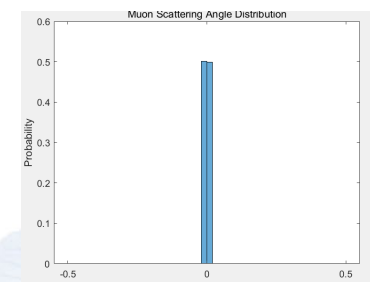
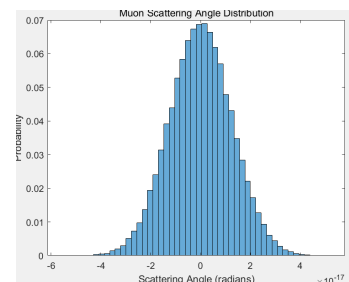
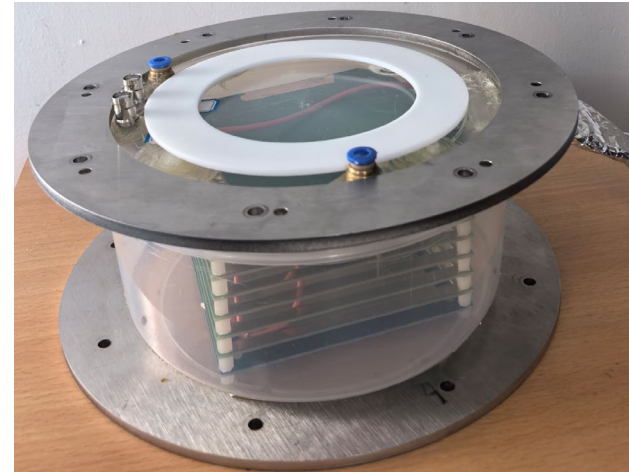
Compact and Lightweight TPC

The compact lightweight TPC is a new type of time projection chamber developed for mobile measurement.

Traditional chambers cause unplanned random scattering

The polyethylene chamber can well accommodate the passage of cosmic rays

balancing noise shielding and portability



R&D of PRC at CIAE

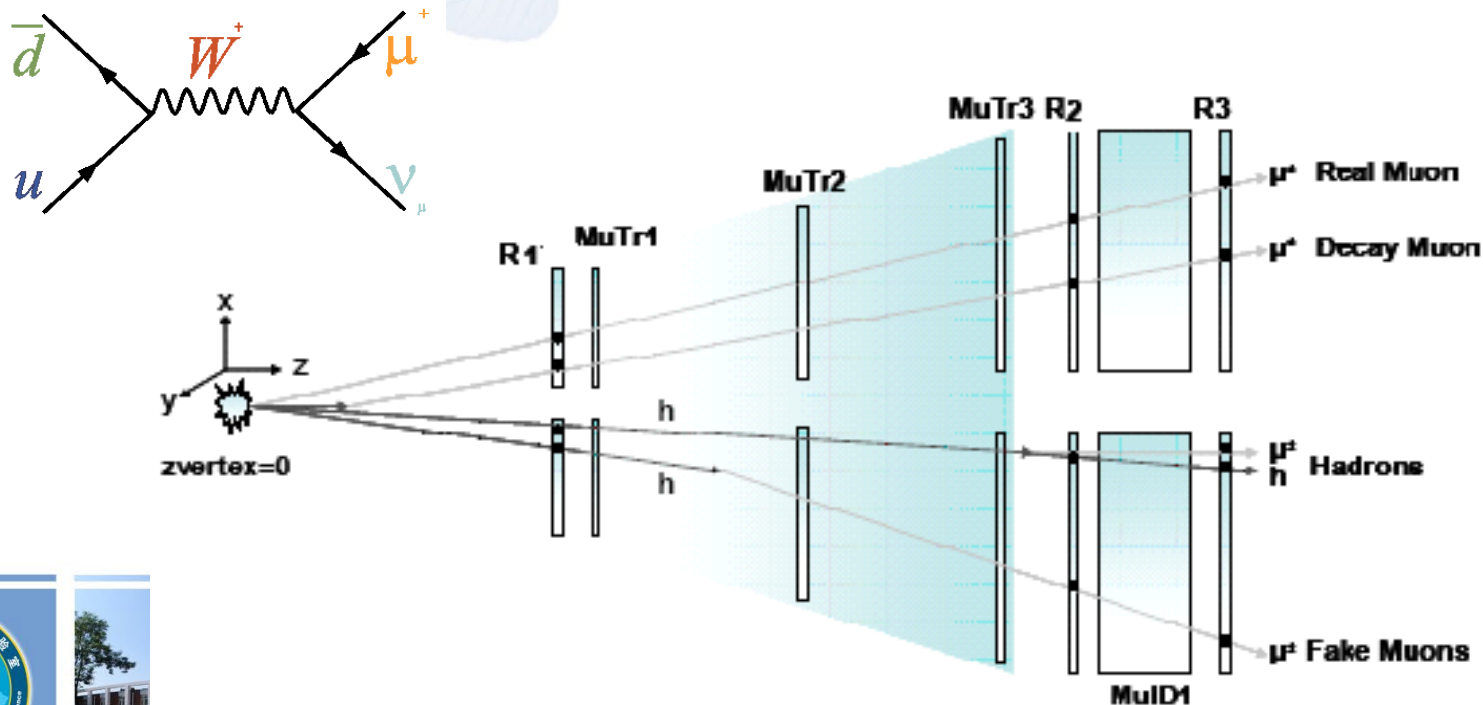


PHENIX@BNL



Motivation of the PHENIX Forward Upgrade

Add RPC (Resistive Plate Chamber) as a fast muon trigger to study the quark-gluon structure of the proton by observing W-bosons from colliding polarized proton beams at RHIC.



RPC Prototypes

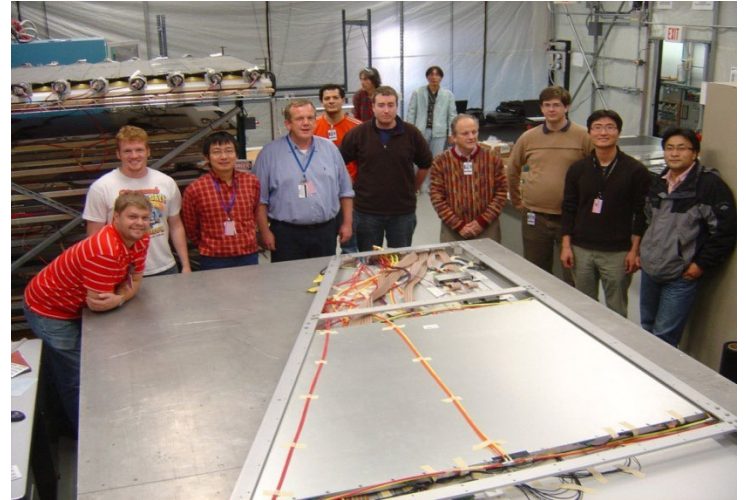


The upstream of Prototype No.2 is separated into two parts and the readout strips are jointed with ground by matched resistances.

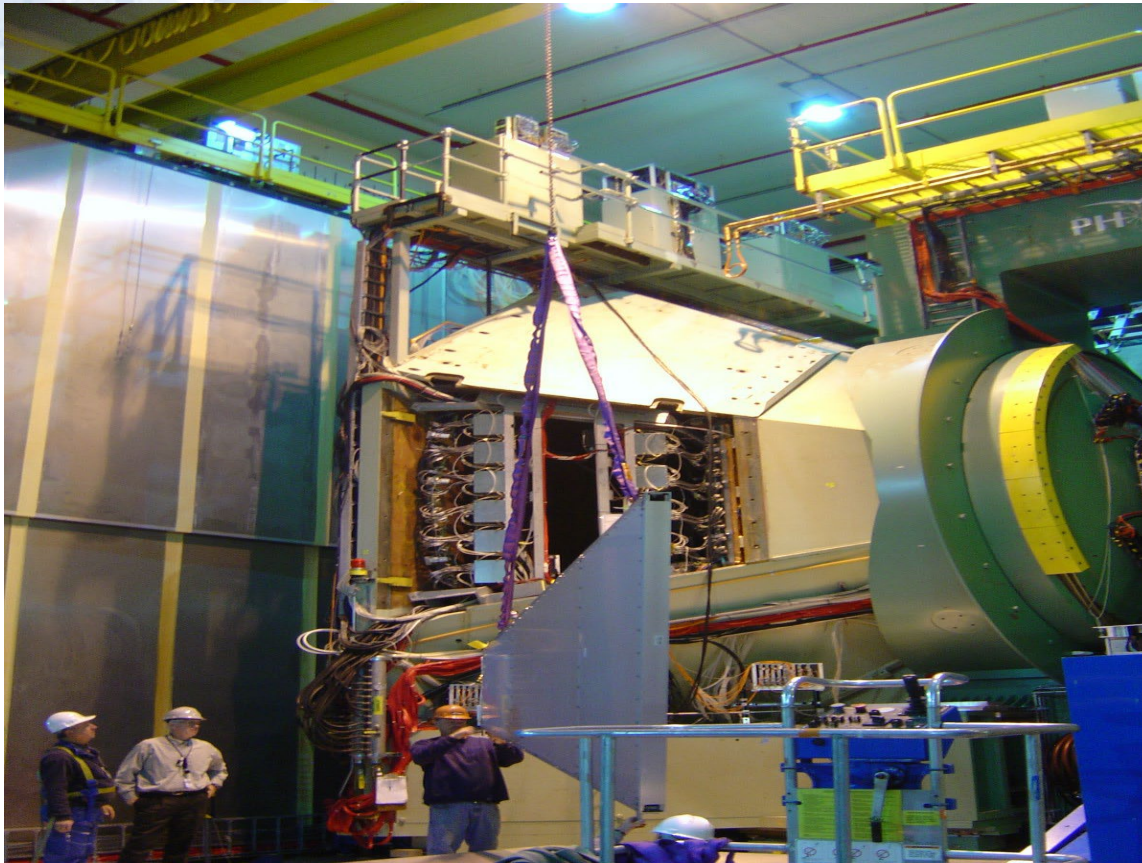


RPC installation at PHENIX

CIAE Carried out the design and production of the module parts of RPC detectors for PHENIX forward upgrade,



RPC installation at PHENIX



This work was awarded the Beijing Science and Technology Prize.



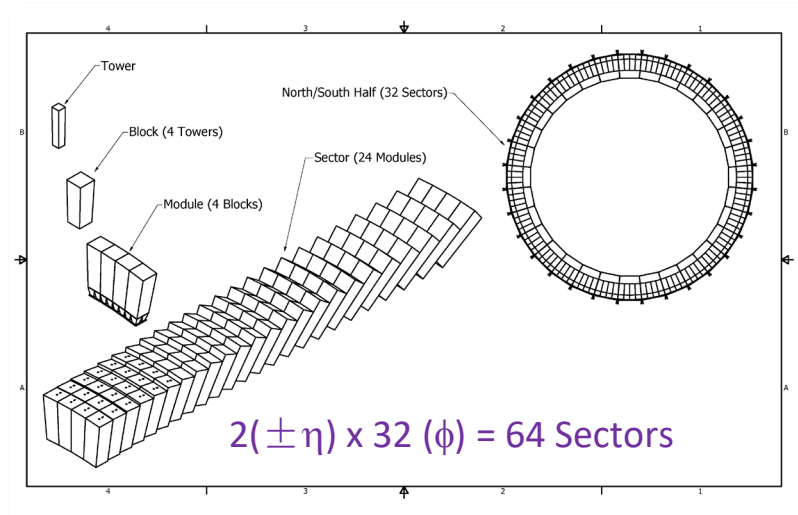
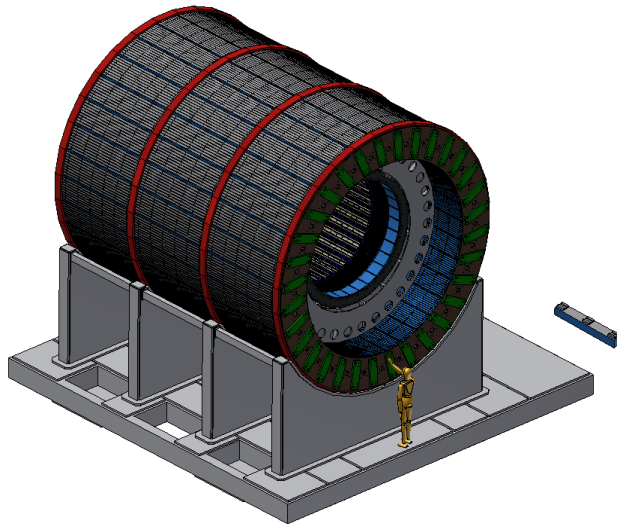
Development of EMCal Detector for sPHENIX



EMCal Design Performance

The EMCal (Electromagnetic Calorimeter) is an essential sub-detector for sPHENIX to measure the QGP near the critical temperature.

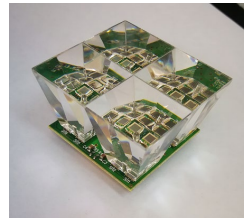
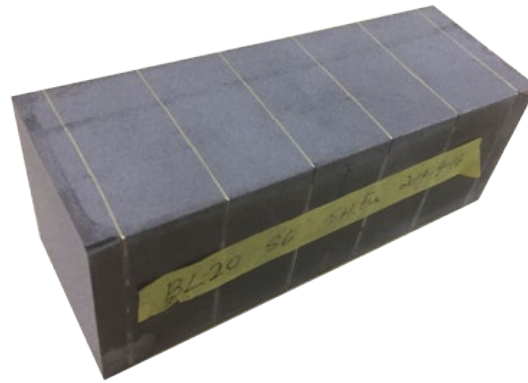
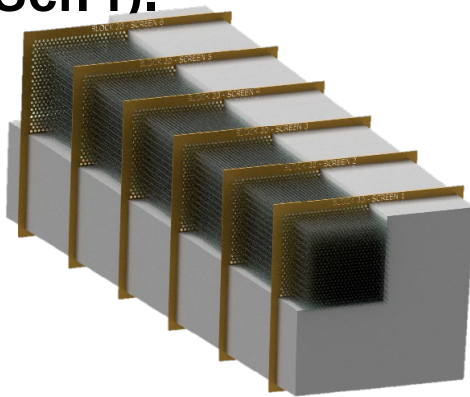
EMCal covering ± 1.1 in η and 2π in ϕ . $\Delta\phi \times \Delta\eta \sim 0.025 \times 0.025$



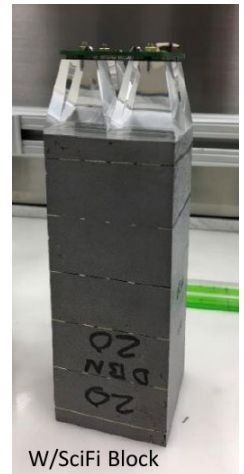
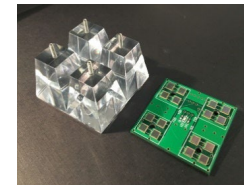
The EMCal performance is central to the direct photon and Upsilon measurements and it is also a key component, along with the HCal, of the jet reconstruction.

EMCal Block Design

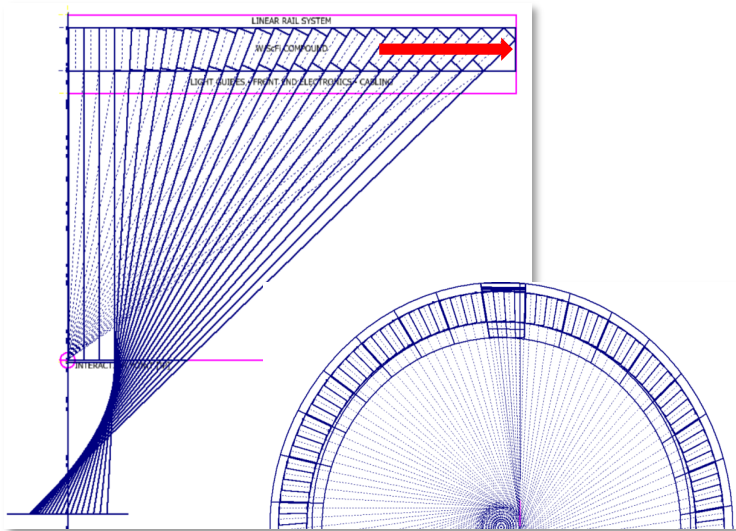
The EMCal block design consists of scintillating fibers embedded in the absorber material, which is a matrix of tungsten powder infused with epoxy (W/SciFi).



- High density (9-10 g/cm³), low radiation length (~7 mm), small Molière radius (~ 2 cm), compact structure and low cost.
- The readout system adopts light guide combined with SiPM.



The Contribution from China

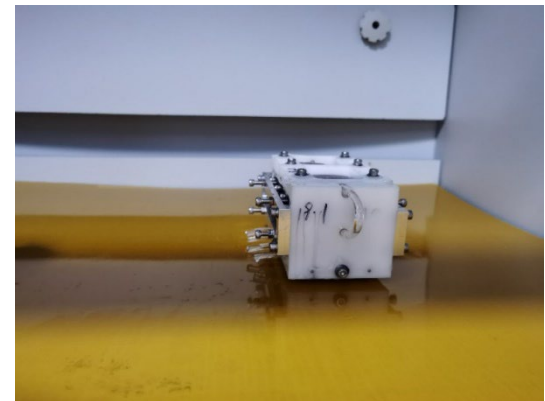
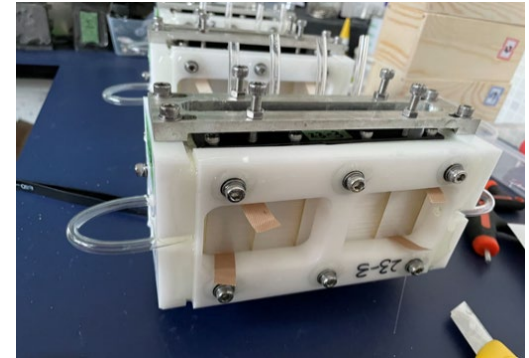


- Total 6144 blocks for EMCal
- 1248 blocks will be made in China.

➤ Fudan, CIAE, and PKU are the main cooperative sites in EMCal construction and make an important contribution to the sPHENIX experiment.

sPHENIX EMCal R&D Center

- 2668 scintillating fibres in one block
- 6340 kg in total
- 97% finished product ratio



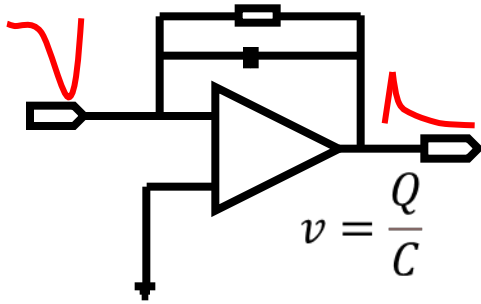
Block Mass Production



Block Mass Production

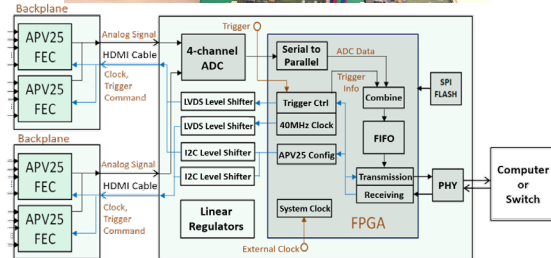


FPGA-Based Readout System for SiPM

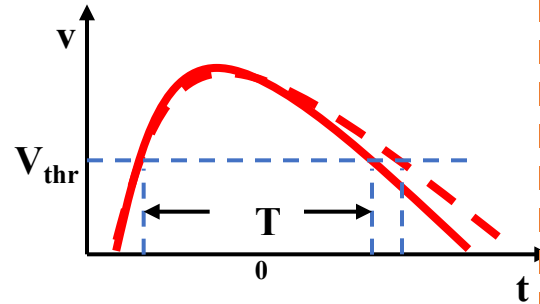


How to measure the voltage?

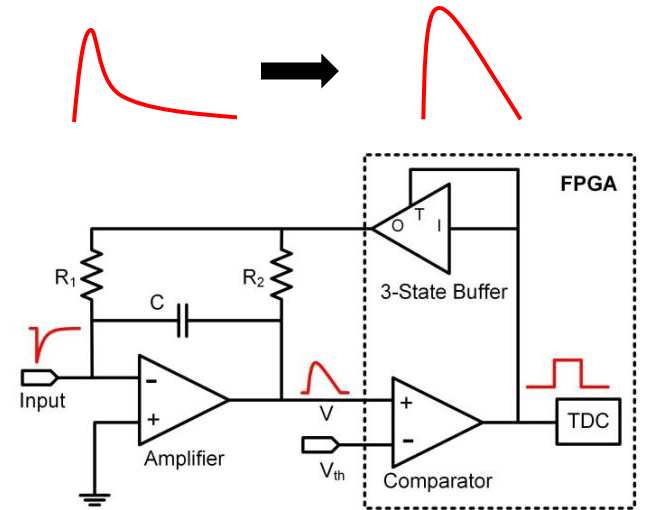
- ADC
- TOT
- FPGA-based method



APV readout system(adc-based)



TOT method



Flexible, low cost, fast speed

$$\int_0^{T_{\text{start}}} \frac{V}{R_1 + R_2} dt + \int_{T_{\text{start}}}^{T_{\text{end}}} \frac{U_0}{R_1} dt + CV_{th} = \int_0^{T_{\text{end}}} i(t) dt$$

$$\frac{U_0}{R_1} (T_{\text{end}} - T_{\text{start}}) \approx \int_0^{T_{\text{end}}} i(t) dt \approx Q$$

TNS.2017.2648787

Linear discharge readout method (FPGA-based)

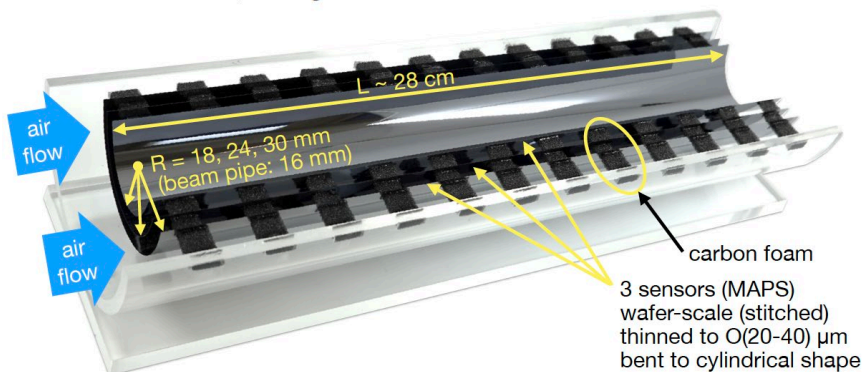
ALICE Upgrade



The ALICE 2.1

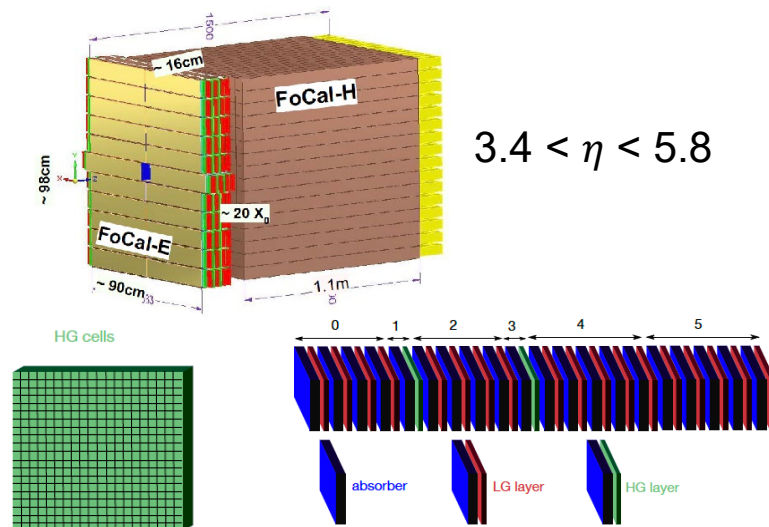


Stitching MAPS-based ITS3



- Replacement of 3 innermost layers of ITS2
- Curved **wafer-scale ultra-thin** silicon sensors: cylindrical layers (1 sensor per half layer)
- Low power → air cooling → low material budget
- Improved tracking precision and efficiency at low p_T

Silicon-based FoCal



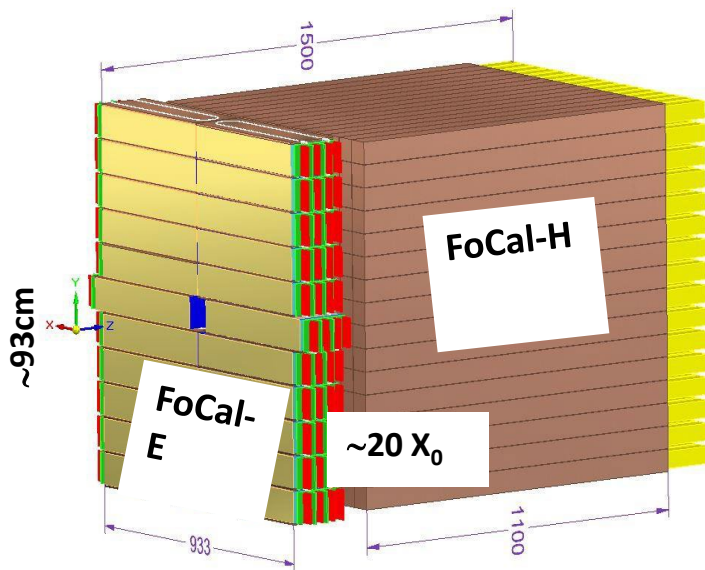
- ✓ Pad ($1 \times 1 \text{ cm}^2$): shower profile and total energy
- ✓ Pixel ($30 \times 30 \text{ μm}^2$): position resolution to resolve overlapping showers

ALICE 2.1 – FoCal Detector

FoCal-H

Spaghetti-like hadronic calorimeter

- Copper tubes with length of 110 cm $\sim 7\lambda_1$ (length constrained by space)
- Inside the copper tubes are scintillating optical fibers
- readout using SiPMs



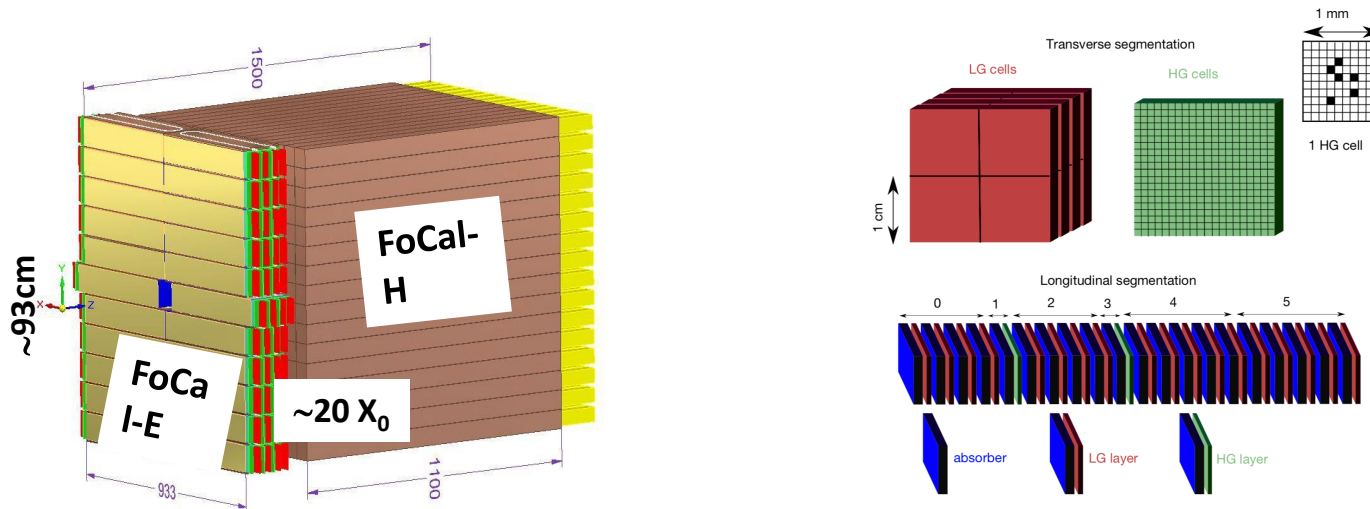
FoCal-H prototype, 9 x (6.5 x 6.5 x 110 cm³)

ALICE 2.1 – FoCal Detector

FoCal-E

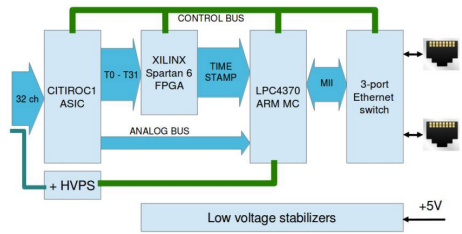
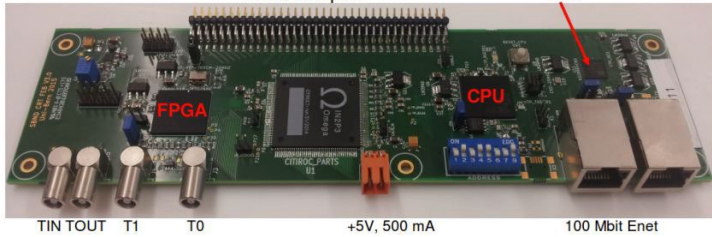
Silicon and tungsten constitute an electro-magnetic calorimeter with an equivalent granularity of approximately 1 mm^2

- 20 layers: Tungsten ($3.5 \text{ mm} \approx 1X_0$) + Silicon sensor
- Two types: Silicon strip (LG) and Silicon pixel (HG).
- Silicon strip provides cluster shape information
- Pixel layer provides high position resolution to resolve clusters with partial overlap

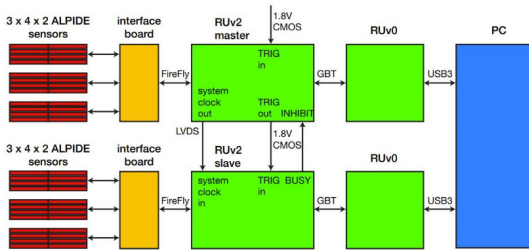


ALICE 2.1-Focal Readout Electronics

M. Auger et al 2016 JINST 11 P10005
32 SiPM inputs

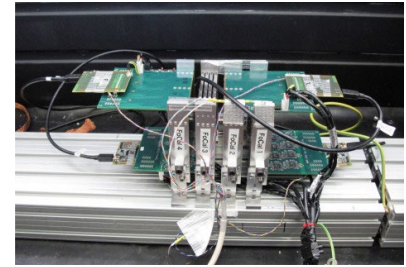
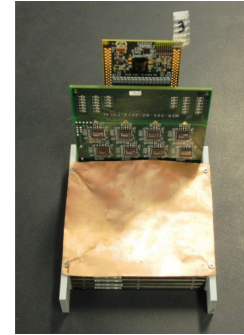
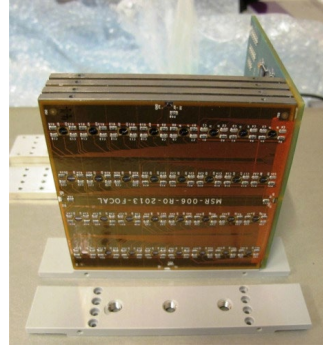


FoCal-H 2021 prototype readout electronics



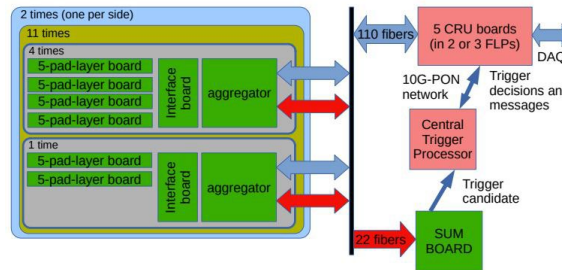
arXiv:2209.02511

FoCal-E pixel layer prototype EPICAL-2 readout electronics

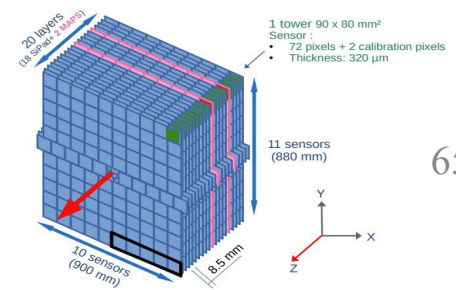


arXiv:1912.11115

For the readout electronics of Focal-H, with a focus on the readout of the SiPM, a number of prototype electronics have been developed that use an ASIC as an analog front-end and an FPGA as a digital back-end. In the case of Focal-E, the electronics scheme chosen is also different due to the different granularity of the pad layer and the pixel layer.

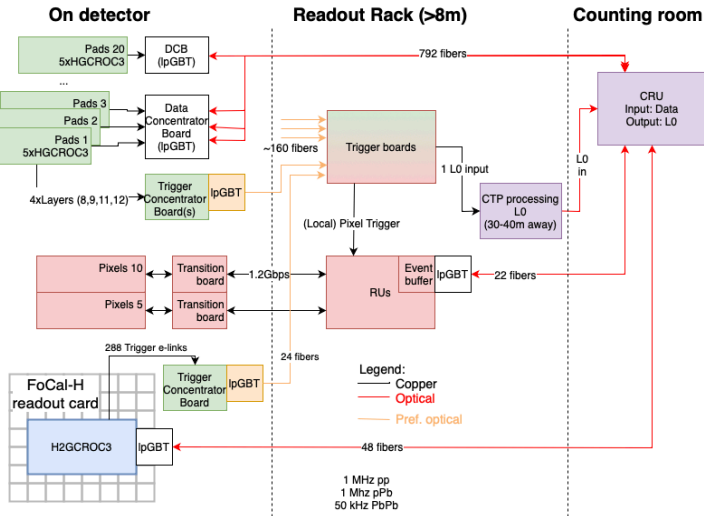


FoCal-E pad layer prototype readout electronics



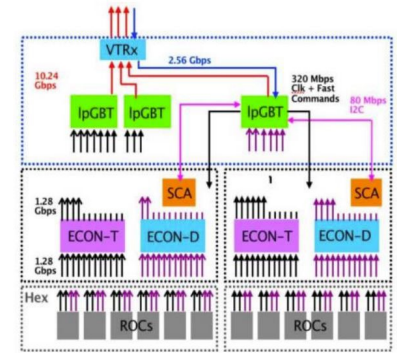
arXiv:2302.13912

ALICE 2.1-Focal Readout System

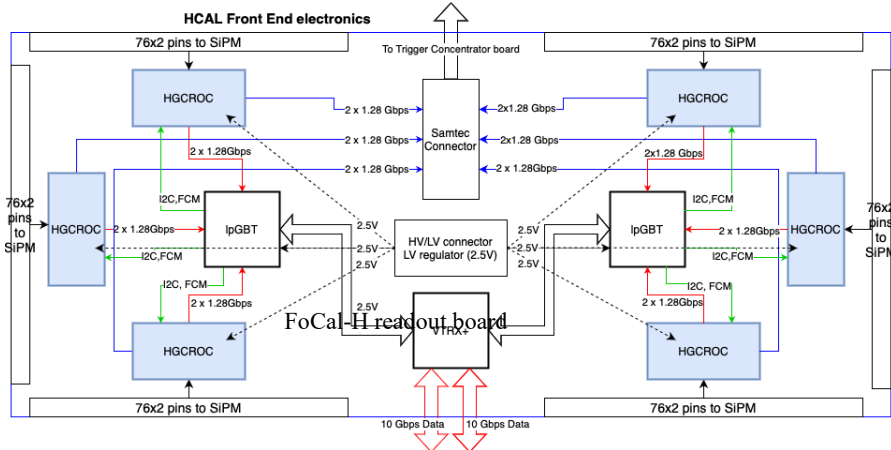


FoCal readout system

Focal Electronics uses HGCROC as the front-end chip, ECON chip for data compression, IpGBT chip for data transmission, and FPGA for control.



CMS CR -2021/228



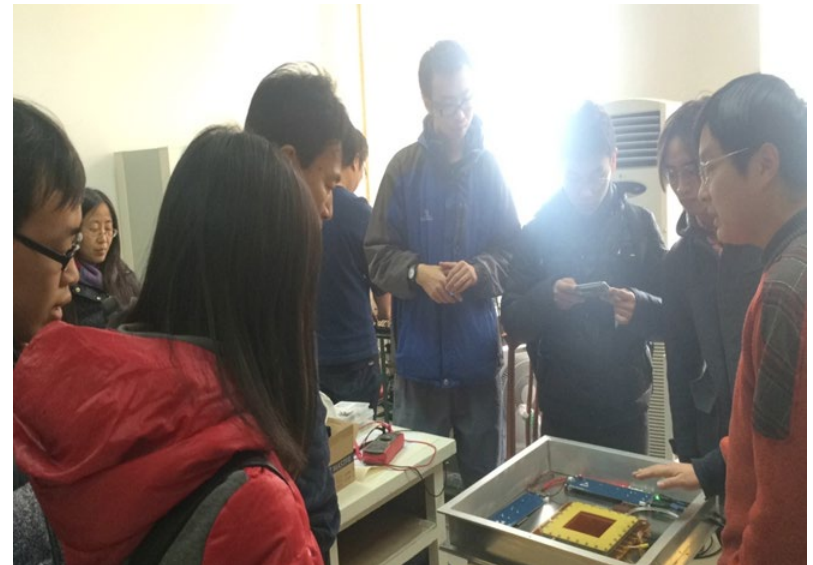
- Protect FPGAs with Long Readout Rack
- Use ECON-D and IpGBT readout pixel data
- ALPIDE pixels use continuous trigger mode, or through signals provided by the Pad layer
- 6 HGCROC, 2 LpGBT, 1 VTRx+
- 6x72 = 432 channels
- Use ECON-D / ECON-T ASIC compress data

CIAE Intermediate and High Energy Physics Team Members

- 2 Professors
- 1 Associate Professor
- 1 Assistant Professor
- 3 Technicians
- ~12 Students

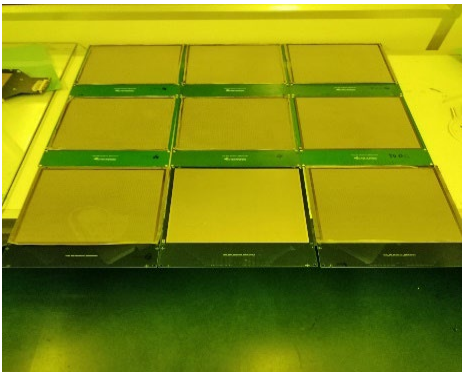


Visitors



Summary and Prospect

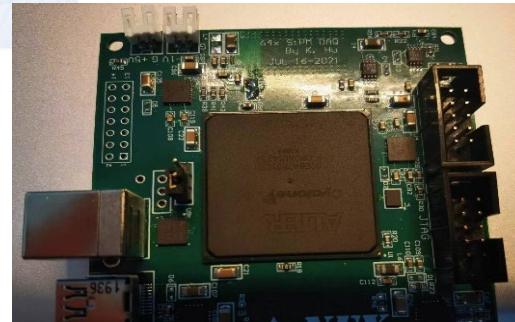
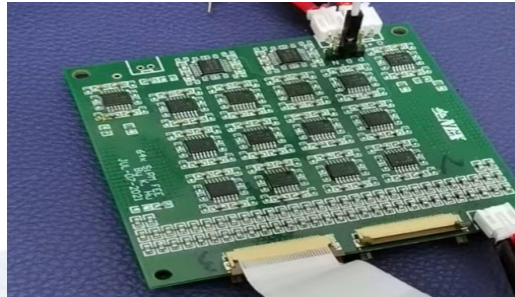
1. Complete R&D and mass production of Advance Gas detectors
2. Complete R&D and mass production of scintillating fibre detectors.
3. Electronics for MPGD and Electronics for SiPM developed by our team are working well. Now we are working on the electronics of ALICE Focal upgrade.
4. CERN/ALICE –CIAE joint lab is under construction.



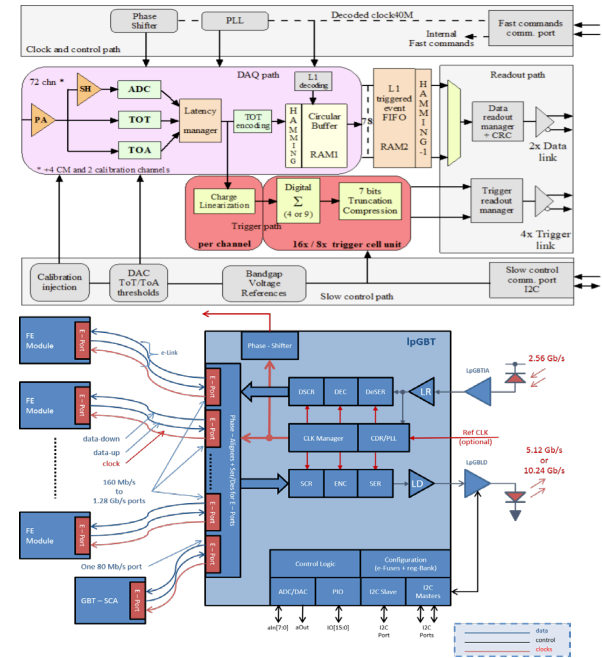
Electronics for Different Detectors



Electronics for
MPGD

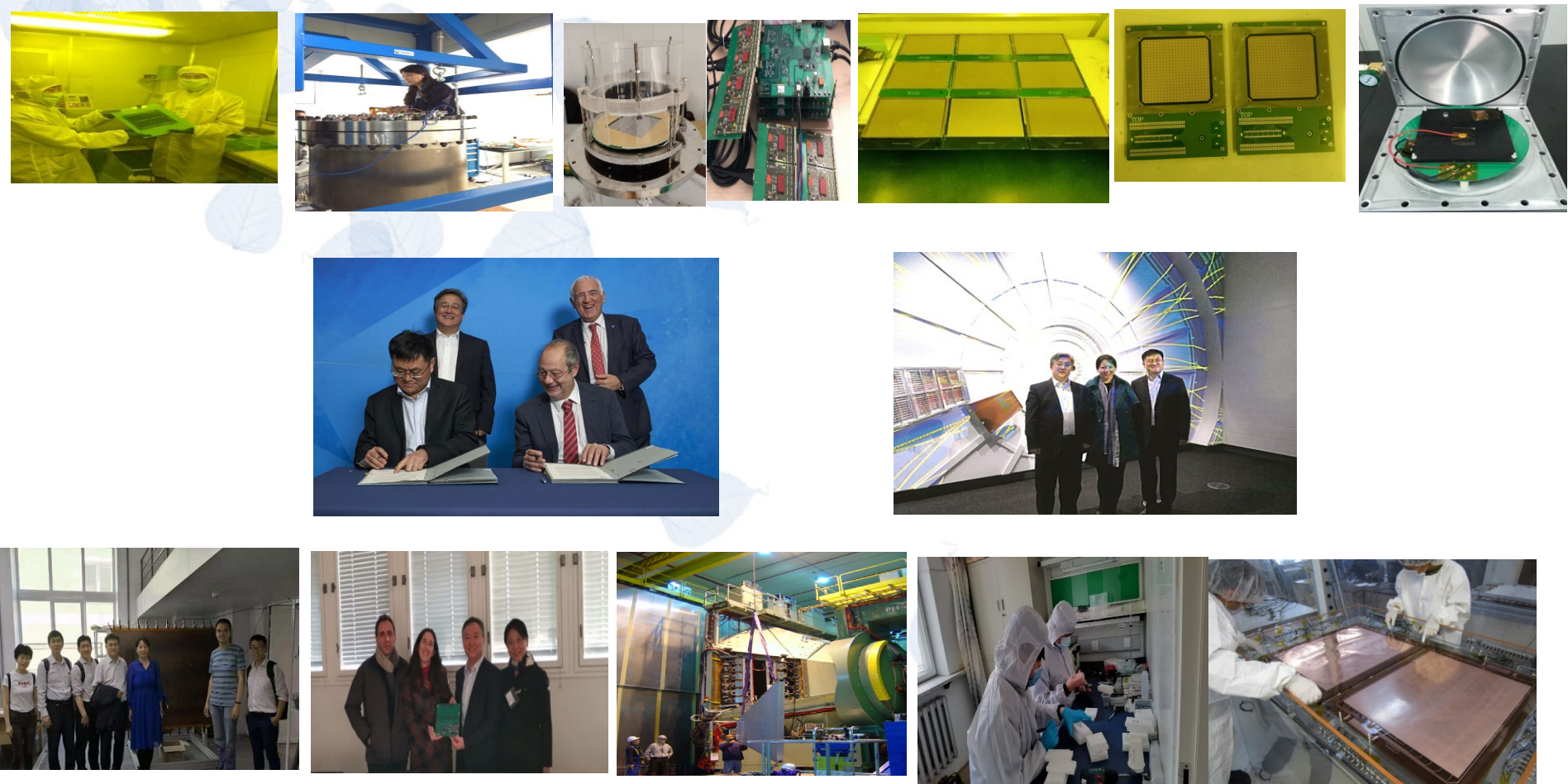


Electronics for
SiPM



Electronics for
ALICE FoCal

Detector Applications and Collaborations



Thanks for your attention!

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